



### FEATURES

**Output frequency range: 137.5 MHz to 4400 MHz**  
**Fractional-N synthesizer and integer-N synthesizer**  
**Low phase noise VCO**  
**Programmable divide-by-1/-2/-4/-8/-16 output**  
**Typical rms jitter: <0.4 ps rms**  
**Power supply: 3.0 V to 3.6 V**  
**Logic compatibility: 1.8 V**  
**Programmable dual-modulus prescaler of 4/5 or 8/9**  
**Programmable output power level**  
**RF output mute function**  
**3-wire serial interface**  
**Analog and digital lock detect**  
**Switched bandwidth fast-lock mode**  
**Cycle slip reduction**

### APPLICATIONS

**Wireless infrastructure (W-CDMA, TD-SCDMA, WiMAX, GSM, PCS, DCS, DECT)**  
**Test equipment**  
**Wireless LANs, CATV equipment**  
**Clock generation**

### GENERAL DESCRIPTION

The ADF4350 allows implementation of fractional-N or integer-N phase-locked loop (PLL) frequency synthesizers if used with an external loop filter and external reference frequency.

The ADF4350 has an integrated voltage controlled oscillator (VCO) with a fundamental output frequency ranging from 2200 MHz to 4400 MHz. In addition, divide-by-1/2/4/8 or 16 circuits allow the user to generate RF output frequencies as low as 137.5 MHz. For applications that require isolation, the RF output stage can be muted. The mute function is both pin- and software-controllable. An auxiliary RF output is also available, which can be powered down if not in use.

Control of all the on-chip registers is through a simple 3-wire interface. The device operates with a power supply ranging from 3.0 V to 3.6 V and can be powered down when not in use.

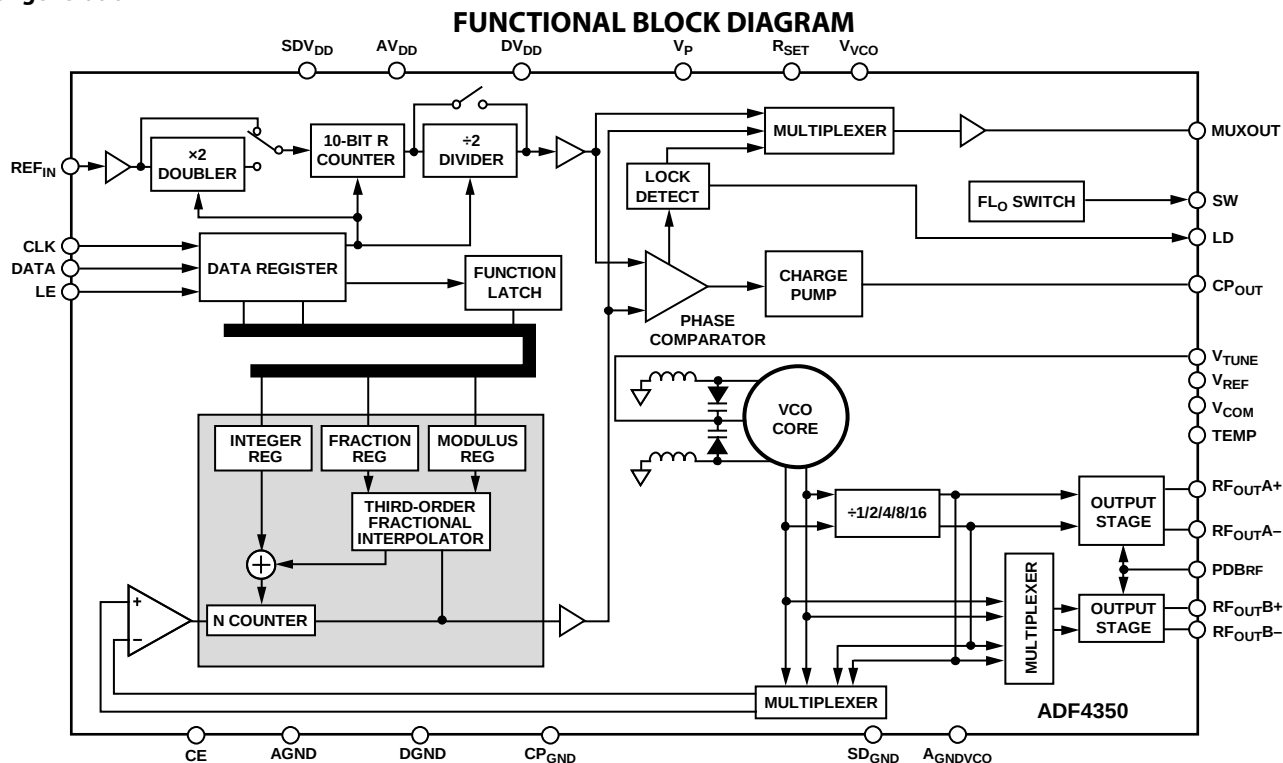


Figure 1.

Rev. B

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## REVISION HISTORY

### 5/16—Rev. A to Rev. B

|                                                                                                         |    |
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| Changes to Figure 3 .....                                                                               | 7  |
| Changes to the ADuC7019 to ADuC7029 Family Interface<br>Section, Figure 35, and Figure 35 Caption ..... | 26 |
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### 11/08—Revision 0: Initial Version

## SPECIFICATIONS

$AV_{DD} = DV_{DD} = V_{VCO} = SDV_{DD} = V_P = 3.3 \text{ V} \pm 10\%$ ;  $AGND = DGND = 0 \text{ V}$ ;  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted. Operating temperature range is  $-40^\circ\text{C}$  to  $+85^\circ\text{C}$ .

Table 1.

| Parameter                                                                | B Version              |                  |                  | Unit  | Test Conditions/Comments                                                                                                                          |
|--------------------------------------------------------------------------|------------------------|------------------|------------------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------|
|                                                                          | Min                    | Typ              | Max              |       |                                                                                                                                                   |
| REF <sub>IN</sub> CHARACTERISTICS                                        |                        |                  |                  |       |                                                                                                                                                   |
| Input Frequency                                                          | 10                     |                  | 250              | MHz   | For f < 10 MHz ensure slew rate > 21 V/μs<br>Biased at AV <sub>DD</sub> /2 <sup>1</sup>                                                           |
| Input Sensitivity                                                        | 0.7                    |                  | AV <sub>DD</sub> | V p-p |                                                                                                                                                   |
| Input Capacitance                                                        |                        | 10               |                  | pF    |                                                                                                                                                   |
| Input Current                                                            |                        |                  | ±60              | μA    |                                                                                                                                                   |
| PHASE DETECTOR                                                           |                        |                  |                  |       |                                                                                                                                                   |
| Phase Detector Frequency <sup>2</sup>                                    |                        |                  | 32               | MHz   |                                                                                                                                                   |
| CHARGE PUMP                                                              |                        |                  |                  |       |                                                                                                                                                   |
| I <sub>CP</sub> Sink/Source <sup>3</sup>                                 |                        |                  |                  |       | With R <sub>SET</sub> = 5.1 kΩ                                                                                                                    |
| High Value                                                               |                        | 5                |                  | mA    |                                                                                                                                                   |
| Low Value                                                                |                        | 0.312            |                  | mA    |                                                                                                                                                   |
| R <sub>SET</sub> Range                                                   | 2.7                    |                  | 10               | kΩ    |                                                                                                                                                   |
| Sink and Source Current Matching                                         |                        | 2                |                  | %     | 0.5 V ≤ V <sub>CP</sub> ≤ 2.5 V                                                                                                                   |
| I <sub>CP</sub> vs. V <sub>CP</sub>                                      |                        | 1.5              |                  | %     | 0.5 V ≤ V <sub>CP</sub> ≤ 2.5 V                                                                                                                   |
| I <sub>CP</sub> vs. Temperature                                          |                        | 2                |                  | %     | V <sub>CP</sub> = 2.0 V                                                                                                                           |
| LOGIC INPUTS                                                             |                        |                  |                  |       |                                                                                                                                                   |
| Input High Voltage, V <sub>INH</sub>                                     | 1.5                    |                  |                  | V     |                                                                                                                                                   |
| Input Low Voltage, V <sub>INL</sub>                                      |                        |                  | 0.6              | V     |                                                                                                                                                   |
| Input Current, I <sub>INH</sub> /I <sub>INL</sub>                        |                        |                  | ±1               | μA    |                                                                                                                                                   |
| Input Capacitance, C <sub>IN</sub>                                       |                        | 3.0              |                  | pF    |                                                                                                                                                   |
| LOGIC OUTPUTS                                                            |                        |                  |                  |       |                                                                                                                                                   |
| Output High Voltage, V <sub>OH</sub>                                     | DV <sub>DD</sub> – 0.4 |                  |                  | V     | CMOS output chosen                                                                                                                                |
| Output High Current, I <sub>OH</sub>                                     |                        |                  | 500              | μA    |                                                                                                                                                   |
| Output Low Voltage, V <sub>OL</sub>                                      |                        |                  | 0.4              | V     | I <sub>OL</sub> = 500 μA                                                                                                                          |
| POWER SUPPLIES                                                           |                        |                  |                  |       |                                                                                                                                                   |
| AV <sub>DD</sub>                                                         | 3.0                    |                  | 3.6              | V     | These voltages must equal AV <sub>DD</sub>                                                                                                        |
| DV <sub>DD</sub> , V <sub>VCO</sub> , SDV <sub>DD</sub> , V <sub>P</sub> |                        | AV <sub>DD</sub> |                  |       |                                                                                                                                                   |
| DI <sub>DD</sub> + AI <sub>DD</sub> <sup>4</sup>                         |                        | 21               | 27               | mA    | Each output divide-by-2 consumes 6 mA                                                                                                             |
| Output Dividers                                                          |                        | 6 to 24          |                  | mA    |                                                                                                                                                   |
| I <sub>VCO</sub> <sup>4</sup>                                            |                        | 70               | 80               | mA    | RF output stage is programmable                                                                                                                   |
| I <sub>RFOUT</sub> <sup>4</sup>                                          |                        | 21               | 26               | mA    |                                                                                                                                                   |
| Low Power Sleep Mode                                                     |                        | 7                | 1000             | μA    |                                                                                                                                                   |
| RF OUTPUT CHARACTERISTICS                                                |                        |                  |                  |       |                                                                                                                                                   |
| Maximum VCO Output Frequency                                             |                        |                  | 4400             | MHz   | Fundamental VCO mode<br>2200 MHz fundamental output and divide by 16 selected                                                                     |
| Minimum VCO Output Frequency                                             | 2200                   |                  |                  | MHz   |                                                                                                                                                   |
| Minimum VCO Output Frequency Using Dividers                              | 137.5                  |                  |                  | MHz   |                                                                                                                                                   |
| VCO Sensitivity                                                          |                        | 33               |                  | MHz/V | Into 2.00 VSWR load<br>Fundamental VCO output<br>Fundamental VCO output<br>Divided VCO output<br>Divided VCO output<br>Programmable in 3 dB steps |
| Frequency Pushing (Open-Loop)                                            |                        | 1                |                  | MHz/V |                                                                                                                                                   |
| Frequency Pulling (Open-Loop)                                            |                        | 90               |                  | kHz   |                                                                                                                                                   |
| Harmonic Content (Second)                                                |                        | –19              |                  | dBc   |                                                                                                                                                   |
| Harmonic Content (Third)                                                 |                        | –13              |                  | dBc   |                                                                                                                                                   |
| Harmonic Content (Second)                                                |                        | –20              |                  | dBc   |                                                                                                                                                   |
| Harmonic Content (Third)                                                 |                        | –10              |                  | dBc   |                                                                                                                                                   |
| Minimum RF Output Power <sup>5</sup>                                     |                        | –4               |                  | dBm   |                                                                                                                                                   |
| Maximum RF Output Power <sup>5</sup>                                     |                        | 5                |                  | dBm   |                                                                                                                                                   |
| Output Power Variation                                                   |                        | ±1               |                  | dB    |                                                                                                                                                   |
| Minimum VCO Tuning Voltage                                               |                        | 0.5              |                  | V     |                                                                                                                                                   |
| Maximum VCO Tuning Voltage                                               |                        | 2.5              |                  | V     |                                                                                                                                                   |

| Parameter                                                        | B Version |      |     | Unit   | Test Conditions/Comments             |
|------------------------------------------------------------------|-----------|------|-----|--------|--------------------------------------|
|                                                                  | Min       | Typ  | Max |        |                                      |
| NOISE CHARACTERISTICS                                            |           |      |     |        |                                      |
| VCO Phase-Noise Performance <sup>6</sup>                         |           | −89  |     | dBc/Hz | 10 kHz offset from 2.2 GHz carrier   |
|                                                                  |           | −114 |     | dBc/Hz | 100 kHz offset from 2.2 GHz carrier  |
|                                                                  |           | −134 |     | dBc/Hz | 1 MHz offset from 2.2 GHz carrier    |
|                                                                  |           | −148 |     | dBc/Hz | 5 MHz offset from 2.2 GHz carrier    |
|                                                                  |           | −86  |     | dBc/Hz | 10 kHz offset from 3.3 GHz carrier   |
|                                                                  |           | −111 |     | dBc/Hz | 100 kHz offset from 3.3 GHz carrier  |
|                                                                  |           | −134 |     | dBc/Hz | 1 MHz offset from 3.3 GHz carrier    |
|                                                                  |           | −145 |     | dBc/Hz | 5 MHz offset from 3.3 GHz carrier    |
|                                                                  |           | −83  |     | dBc/Hz | 10 kHz offset from 4.4 GHz carrier   |
|                                                                  |           | −110 |     | dBc/Hz | 100 kHz offset from 4.4 GHz carrier  |
|                                                                  |           | −132 |     | dBc/Hz | 1 MHz offset from 4.4 GHz carrier    |
|                                                                  |           | −145 |     | dBc/Hz | 5 MHz offset from 4.4 GHz carrier    |
| Normalized Phase Noise Floor (PN <sub>SYNTH</sub> ) <sup>7</sup> |           | −220 |     | dBc/Hz | PLL Loop BW = 500 kHz                |
| Normalized 1/f Noise (PN <sub>1-f</sub> ) <sup>8</sup>           |           | −111 |     | dBc/Hz | 10 kHz offset; normalized to 1 GHz   |
| In-Band Phase Noise <sup>9</sup>                                 |           | −97  |     | dBc/Hz | 3 kHz offset from 2113.5 MHz carrier |
| Integrated RMS Jitter <sup>10</sup>                              |           | 0.5  |     | ps     |                                      |
| Spurious Signals Due to PFD Frequency                            |           | −70  |     | dBc    |                                      |
| Level of Signal With RF Mute Enabled                             |           | −40  |     | dBm    |                                      |

<sup>1</sup> AC coupling ensures  $AV_{DD}/2$  bias.

<sup>2</sup> Guaranteed by design. Sample tested to ensure compliance.

<sup>3</sup>  $I_{CP}$  is internally modified to maintain constant loop gain over the frequency range.

<sup>4</sup>  $T_A = 25^\circ\text{C}$ ;  $AV_{DD} = DV_{DD} = V_{VCO} = 3.3\text{ V}$ ; prescaler = 8/9;  $f_{REFIN} = 100\text{ MHz}$ ;  $f_{PFD} = 25\text{ MHz}$ ;  $f_{RF} = 4.4\text{ GHz}$ .

<sup>5</sup> Using 50  $\Omega$  resistors to  $V_{VCO}$ , into a 50  $\Omega$  load. Power measured with auxiliary RF output disabled. The current consumption of the auxiliary output is the same as for the main output.

<sup>6</sup> The noise of the VCO is measured in open-loop conditions.

<sup>7</sup> The synthesizer phase noise floor is estimated by measuring the in-band phase noise at the output of the VCO and subtracting  $20 \log N$  (where N is the N divider value) and  $10 \log F_{PFD}$ .  $PN_{SYNTH} = PN_{TOT} - 10 \log F_{PFD} - 20 \log N$ .

<sup>8</sup> The PLL phase noise is composed of 1/f (flicker) noise plus the normalized PLL noise floor. The formula for calculating the 1/f noise contribution at an RF frequency,  $f_{RF}$ , and at a frequency offset f is given by  $PN = P_{1-f} + 10 \log(10 \text{ kHz}/f) + 20 \log(f_{RF}/1 \text{ GHz})$ . Both the normalized phase noise floor and flicker noise are modeled in ADIsimPLL.

<sup>9</sup>  $f_{REFIN} = 100\text{ MHz}$ ;  $f_{PFD} = 25\text{ MHz}$ ; offset frequency = 10 kHz; VCO frequency = 4227 MHz, output divide by two enabled.  $RF_{OUT} = 2113.5\text{ MHz}$ ; N = 169; loop BW = 40 kHz,  $I_{CP} = 313\text{ }\mu\text{A}$ ; low noise mode. The noise was measured with an EVAL-ADF4350EB1Z and the Agilent E5052A signal source analyzer.

<sup>10</sup>  $f_{REFIN} = 100\text{ MHz}$ ;  $f_{PFD} = 25\text{ MHz}$ ; VCO frequency = 4400 MHz,  $RF_{OUT} = 4400\text{ MHz}$ ; N = 176; loop BW = 40 kHz,  $I_{CP} = 313\text{ }\mu\text{A}$ ; low noise mode. The noise was measured with an EVAL-ADF4350EB1Z and the Agilent E5052A signal source analyzer.

**TIMING CHARACTERISTICS**

$AV_{DD} = DV_{DD} = V_{VCO} = SDV_{DD} = V_P = 3.3\text{ V} \pm 10\%$ ;  $AGND = DGND = 0\text{ V}$ ; 1.8 V and 3 V logic levels used;  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.

**Table 2.**

| Parameter | Limit (B Version) | Unit   | Test Conditions/Comments |
|-----------|-------------------|--------|--------------------------|
| $t_1$     | 20                | ns min | LE setup time            |
| $t_2$     | 10                | ns min | DATA to CLK setup time   |
| $t_3$     | 10                | ns min | DATA to CLK hold time    |
| $t_4$     | 25                | ns min | CLK high duration        |
| $t_5$     | 25                | ns min | CLK low duration         |
| $t_6$     | 10                | ns min | CLK to LE setup time     |
| $t_7$     | 20                | ns min | LE pulse width           |

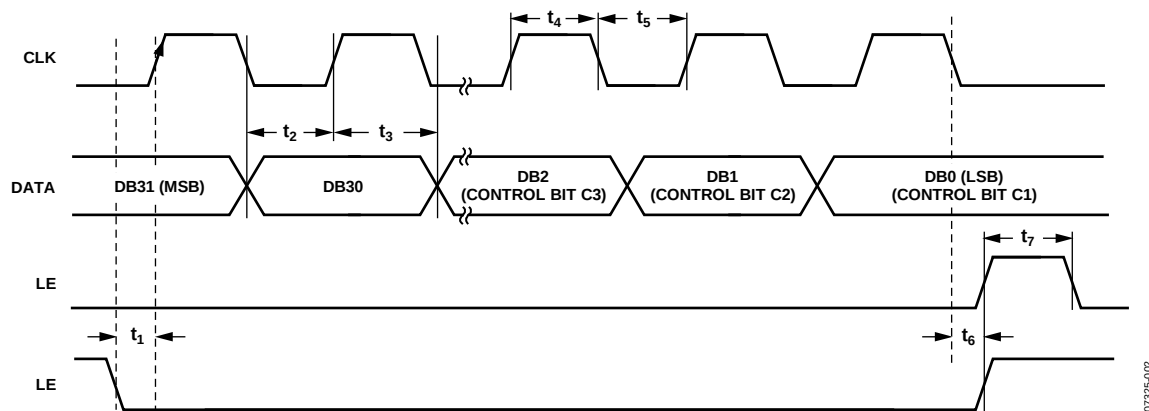


Figure 2. Timing Diagram

07325-002

## ABSOLUTE MAXIMUM RATINGS

$T_A = 25^\circ\text{C}$ , unless otherwise noted.

Table 3.

| Parameter                                                  | Rating                     |
|------------------------------------------------------------|----------------------------|
| $AV_{DD}$ to GND <sup>1</sup>                              | –0.3 V to +3.9 V           |
| $AV_{DD}$ to $DV_{DD}$                                     | –0.3 V to +0.3 V           |
| $V_{VCO}$ to GND                                           | –0.3 V to +3.9 V           |
| $V_{VCO}$ to $AV_{DD}$                                     | –0.3 V to +0.3 V           |
| Digital Input/Output Voltage to GND                        | –0.3 V to $V_{DD} + 0.3$ V |
| Analog Input/Output Voltage to GND                         | –0.3 V to $V_{DD} + 0.3$ V |
| $REF_{IN}$ to GND                                          | –0.3 V to $V_{DD} + 0.3$ V |
| Operating Temperature Range                                | –40°C to +85°C             |
| Storage Temperature Range                                  | –65°C to +125°C            |
| Maximum Junction Temperature                               | 150°C                      |
| LFCSP $\theta_{JA}$ Thermal Impedance<br>(Paddle-Soldered) | 27.3°C/W                   |
| Reflow Soldering                                           |                            |
| Peak Temperature                                           | 260°C                      |
| Time at Peak Temperature                                   | 40 sec                     |

<sup>1</sup> GND = AGND = DGND = 0 V

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

This device is a high-performance RF integrated circuit with an ESD rating of <0.5 kV and is ESD sensitive. Proper precautions must be taken for handling and assembly.

### TRANSISTOR COUNT

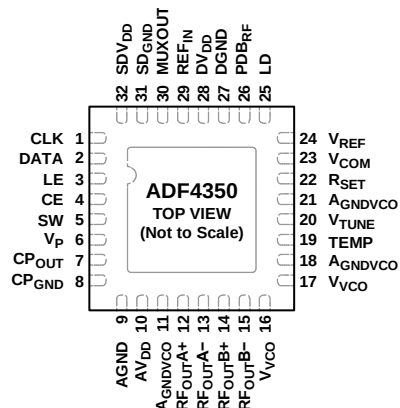
24202 (CMOS) and 918 (bipolar).

### ESD CAUTION



**ESD (electrostatic discharge) sensitive device.** Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



## NOTES

1. THE LFCSP HAS AN EXPOSED PADDLE THAT MUST BE CONNECTED TO GND.

07325-003

Figure 3. Pin Configuration

Table 4. Pin Function Descriptions

| Pin No.    | Mnemonic            | Description                                                                                                                                                                                                                    |
|------------|---------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1          | CLK                 | Serial Clock Input. Data is clocked into the 32-bit shift register on the CLK rising edge. This input is a high impedance CMOS input.                                                                                          |
| 2          | DATA                | Serial Data Input. The serial data is loaded MSB first with the three LSBs as the control bits. This input is a high impedance CMOS input.                                                                                     |
| 3          | LE                  | Load Enable, CMOS Input. When LE goes high, the data stored in the shift register is loaded into the register that is selected by the three LSBs.                                                                              |
| 4          | CE                  | Chip Enable. A logic low on this pin powers down the device and puts the charge pump into three-state mode. A logic high on this pin powers up the device depending on the status of the power-down bits.                      |
| 5          | SW                  | Fast-Lock Switch. A connection must be made from the loop filter to this pin when using the fast-lock mode.                                                                                                                    |
| 6          | V <sub>P</sub>      | Charge Pump Power Supply. This pin is to be equal to AV <sub>DD</sub> . Decoupling capacitors to the ground plane are to be placed as close as possible to this pin.                                                           |
| 7          | CP <sub>OUT</sub>   | Charge Pump Output. When enabled, this provides $\pm I_{CP}$ to the external loop filter. The output of the loop filter is connected to V <sub>TUNE</sub> to drive the internal VCO.                                           |
| 8          | CP <sub>GND</sub>   | Charge Pump Ground. This is the ground return pin for CP <sub>OUT</sub> .                                                                                                                                                      |
| 9          | AGND                | Analog Ground. This is a ground return pin for AV <sub>DD</sub> .                                                                                                                                                              |
| 10         | AV <sub>DD</sub>    | Analog Power Supply. This pin ranges from 3.0 V to 3.6 V. Decoupling capacitors to the analog ground plane are to be placed as close as possible to this pin. AV <sub>DD</sub> must have the same value as DV <sub>DD</sub> .  |
| 11, 18, 21 | AGNDVCO             | VCO Analog Ground. These are the ground return pins for the VCO.                                                                                                                                                               |
| 12         | RF <sub>OUTA+</sub> | VCO Output. The output level is programmable. The VCO fundamental output or a divided down version is available.                                                                                                               |
| 13         | RF <sub>OUTA-</sub> | Complementary VCO Output. The output level is programmable. The VCO fundamental output or a divided down version is available.                                                                                                 |
| 14         | RF <sub>OUTB+</sub> | Auxilliary VCO Output. The output level is programmable. The VCO fundamental output or a divided down version is available.                                                                                                    |
| 15         | RF <sub>OUTB-</sub> | Complementary Auxilliary VCO Output. The output level is programmable. The VCO fundamental output or a divided down version is available.                                                                                      |
| 16, 17     | V <sub>VCO</sub>    | Power Supply for the VCO. This ranges from 3.0 V to 3.6 V. Decoupling capacitors to the analog ground plane must be placed as close as possible to these pins. V <sub>VCO</sub> must have the same value as AV <sub>DD</sub> . |
| 19         | TEMP                | Temperature Compensation Output. Decoupling capacitors to the ground plane are to be placed as close as possible to this pin.                                                                                                  |
| 20         | V <sub>TUNE</sub>   | Control Input to the VCO. This voltage determines the output frequency and is derived from filtering the CP <sub>OUT</sub> output voltage.                                                                                     |

| Pin No. | Mnemonic          | Description                                                                                                                                                                                                                                                                                                           |
|---------|-------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 22      | R <sub>SET</sub>  | Connecting a resistor between this pin and GND sets the charge pump output current. The nominal voltage bias at the R <sub>SET</sub> pin is 0.55 V. The relationship between I <sub>CP</sub> and R <sub>SET</sub> is<br>$I_{CP} = \frac{25.5}{R_{SET}}$ where:<br>R <sub>SET</sub> = 5.1 kΩ<br>I <sub>CP</sub> = 5 mA |
| 23      | V <sub>COM</sub>  | Internal Compensation Node Biased at Half the Tuning Range. Decoupling capacitors to the ground plane must be placed as close as possible to this pin.                                                                                                                                                                |
| 24      | V <sub>REF</sub>  | Reference Voltage. Decoupling capacitors to the ground plane must be placed as close as possible to this pin.                                                                                                                                                                                                         |
| 25      | LD                | Lock Detect Output Pin. This pin outputs a logic high to indicate PLL lock. A logic low output indicates loss of PLL lock.                                                                                                                                                                                            |
| 26      | PDB <sub>RF</sub> | RF Power-Down. A logic low on this pin mutes the RF outputs. This function is also software controllable.                                                                                                                                                                                                             |
| 27      | DGND              | Digital Ground. Ground return path for DV <sub>DD</sub> .                                                                                                                                                                                                                                                             |
| 28      | DV <sub>DD</sub>  | Digital Power Supply. This pin must be the same voltage as AV <sub>DD</sub> . Decoupling capacitors to the ground plane must be placed as close as possible to this pin.                                                                                                                                              |
| 29      | REF <sub>IN</sub> | Reference Input. This is a CMOS input with a nominal threshold of V <sub>DD</sub> /2 and a dc equivalent input resistance of 100 kΩ. This input can be driven from a TTL or CMOS crystal oscillator, or it can be ac-coupled.                                                                                         |
| 30      | MUXOUT            | Multiplexer Output. This multiplexer output allows either the lock detect, the scaled RF, or the scaled reference frequency to be accessed externally.                                                                                                                                                                |
| 31      | SD <sub>GND</sub> | Digital Sigma-Delta (Σ-Δ) Modulator Ground. Ground return path for the Σ-Δ modulator.                                                                                                                                                                                                                                 |
| 32      | SDV <sub>DD</sub> | Power Supply Pin for the Digital Σ-Δ Modulator. Must be the same voltage as AV <sub>DD</sub> . Decoupling capacitors to the ground plane are to be placed as close as possible to this pin.                                                                                                                           |
| 33      | EP                | Exposed Pad.                                                                                                                                                                                                                                                                                                          |



## TYPICAL PERFORMANCE CHARACTERISTICS

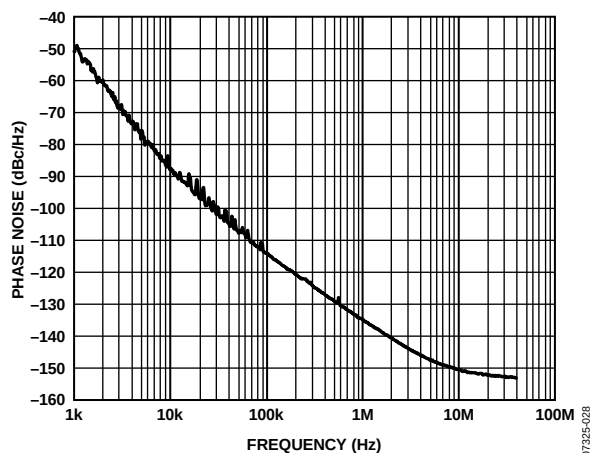


Figure 4. Open-Loop VCO Phase Noise, 2.2 GHz

07325-028

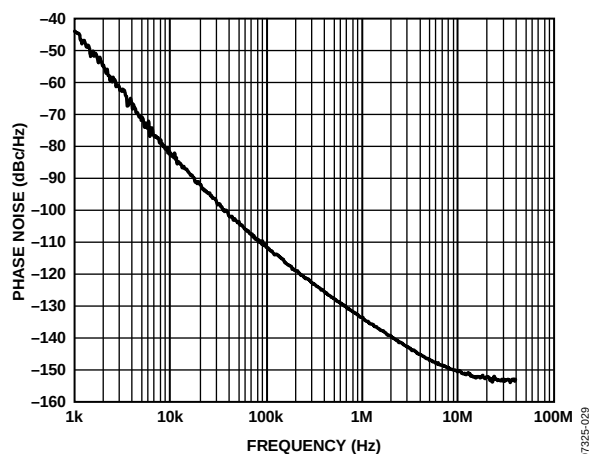


Figure 5. Open-Loop VCO Phase Noise, 3.3 GHz

07325-029

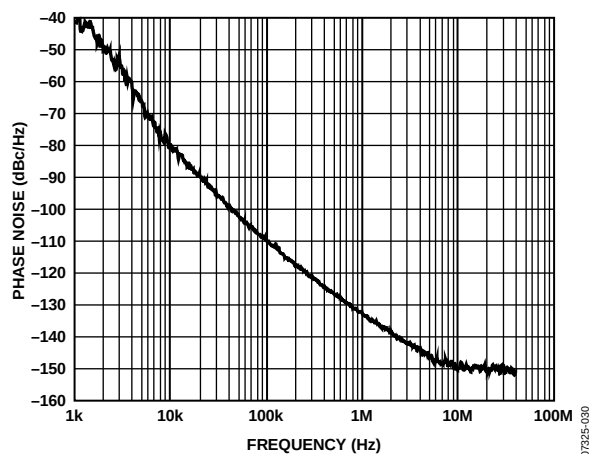


Figure 6. Open-Loop VCO Phase Noise, 4.4 GHz

07325-030

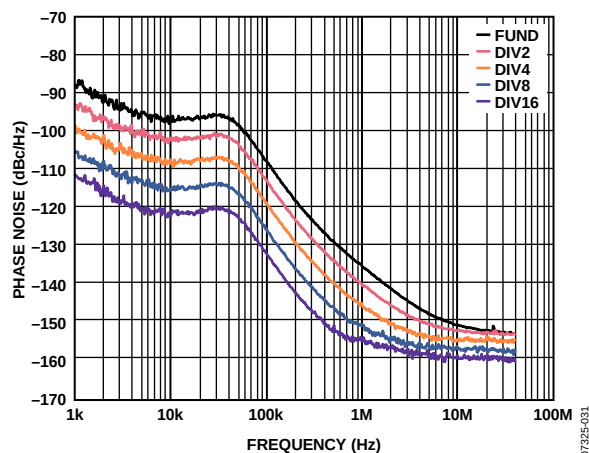


Figure 7. Closed-Loop Phase Noise, Fundamental VCO and Dividers, VCO = 2.2 GHz, PFD = 25 MHz, Loop Bandwidth = 40 kHz

07325-031

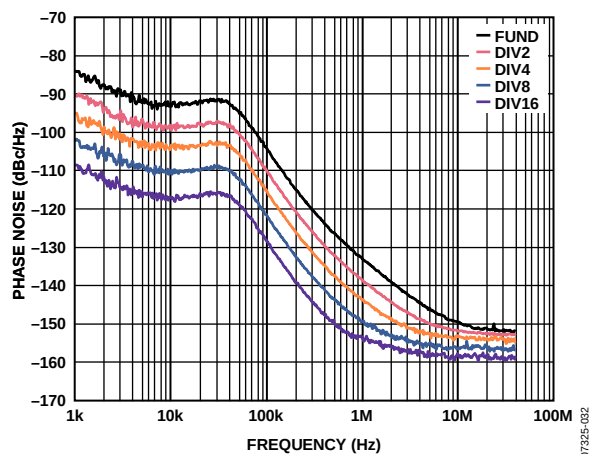


Figure 8. Closed-Loop Phase Noise, Fundamental VCO and Dividers, VCO = 3.3 GHz, PFD = 25 MHz, Loop Bandwidth = 40 kHz

07325-032

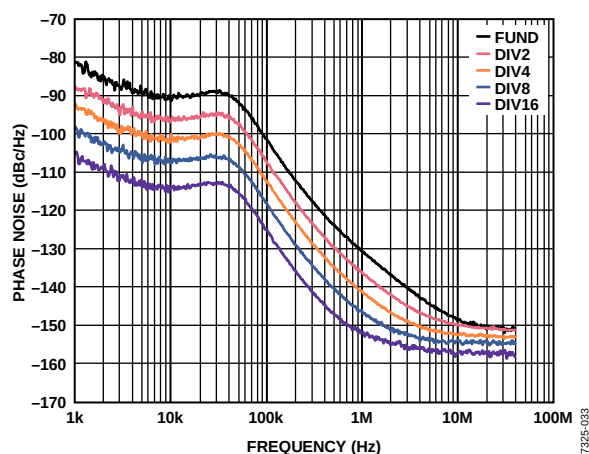


Figure 9. Closed-Loop Phase Noise, Fundamental VCO and Dividers, VCO = 4.4 GHz, PFD = 25 MHz, Loop Bandwidth = 40 kHz

07325-033

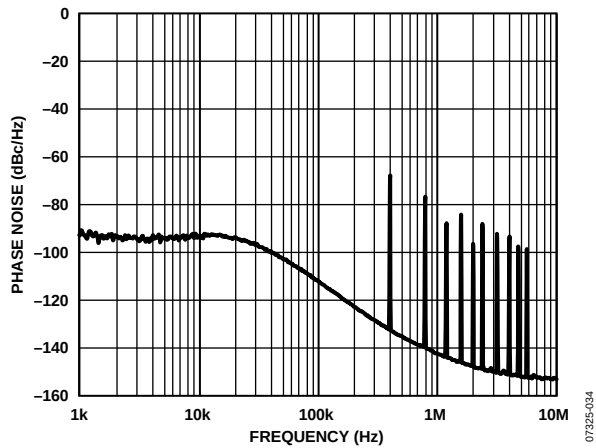


Figure 10. Integer-N Phase Noise and Spur Performance. GSM900 Band,  $R_{FOUT} = 904$  MHz,  $R_{FIN} = 100$  MHz, PFD = 800 kHz, Output Divide-by-4 Selected; Loop-Filter Bandwidth = 16 kHz, Channel Spacing = 200 kHz.

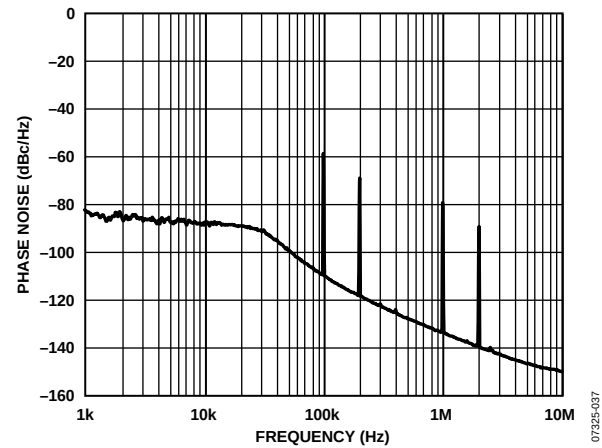


Figure 13. Fractional-N Spur Performance. Low Noise Mode,  $R_{FOUT} = 2.591$  GHz,  $R_{FIN} = 105$  MHz, PFD = 17.5 MHz, Output Divide-by-1 Selected; Loop Filter Bandwidth = 20 kHz, Channel Spacing = 100 kHz.

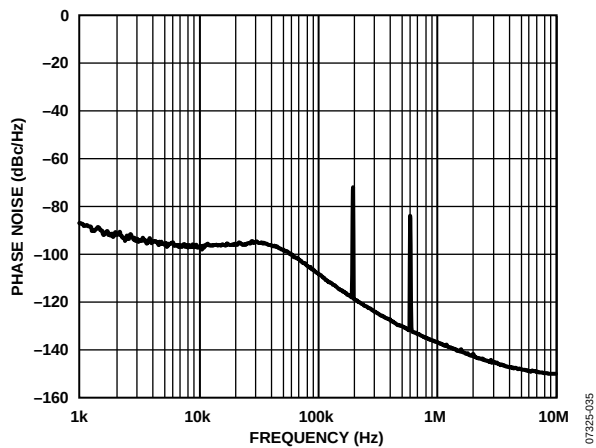


Figure 11. Fractional-N Spur Performance; Low Noise Mode. W-CDMA Band,  $R_{FOUT} = 2113.5$  MHz,  $R_{FIN} = 100$  MHz, PFD = 25 MHz, Output Divide-by-2 Selected; Loop Filter Bandwidth = 40 kHz, Channel Spacing = 200 kHz.

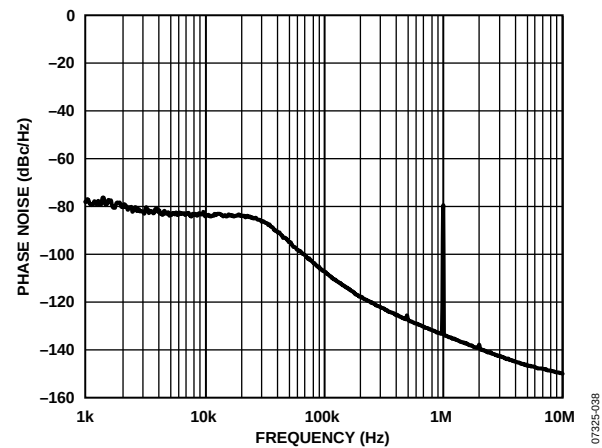


Figure 14. Fractional-N Spur Performance. Low Spur Mode  $R_{FOUT} = 2.591$  GHz,  $R_{FIN} = 105$  MHz, PFD = 17.5 MHz, Output Divide-by-1 Selected. Loop Filter Bandwidth = 20 kHz, Channel Spacing = 100 kHz (Note That Fractional Spurs Are Removed and Only the Integer Boundary Spur Remains in Low Spur Mode).

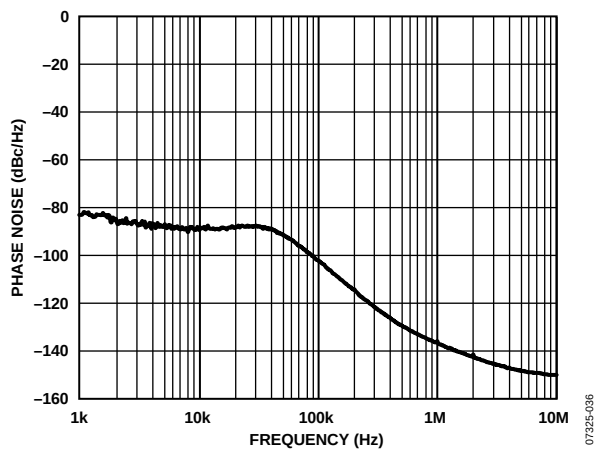


Figure 12. Fractional-N Spur Performance. Low Spur Mode, W-CDMA Band  $R_{FOUT} = 2113.5$  MHz,  $R_{FIN} = 100$  MHz, PFD = 25 MHz, Output Divide-by-2 Selected; Loop Filter Bandwidth = 40 kHz, Channel Spacing = 200 kHz

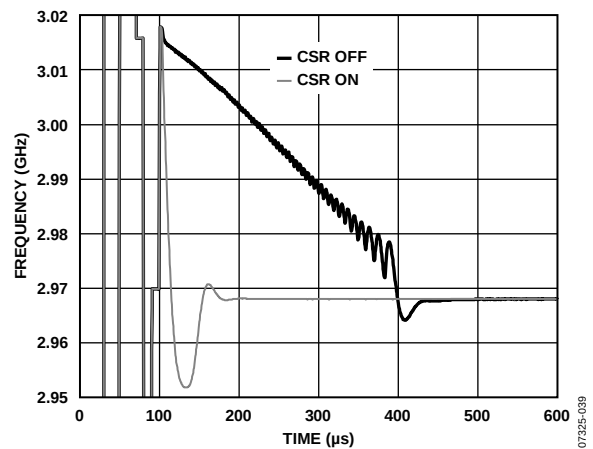


Figure 15. Lock Time for 100 MHz Jump from 3070 MHz to 2970 MHz with CSR On and Off, PFD = 25 MHz,  $I_{CP} = 313$   $\mu$ A, Loop Filter Bandwidth = 20 kHz

## CIRCUIT DESCRIPTION

### REFERENCE INPUT SECTION

The reference input stage is shown in Figure 16. SW1 and SW2 are normally closed switches. SW3 is normally open. When power-down is initiated, SW3 is closed, and SW1 and SW2 are opened. This ensures that there is no loading of the REF<sub>IN</sub> pin during power-down.

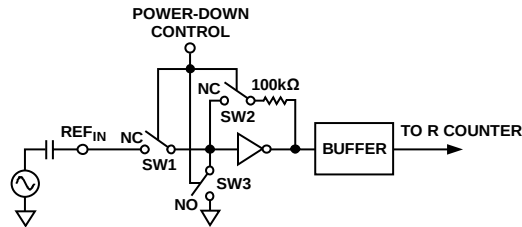


Figure 16. Reference Input Stage

### RF N DIVIDER

The RF N divider allows a division ratio in the PLL feedback path. The division ratio is determined by INT, FRAC and MOD values, which build up this divider.

### INT, FRAC, MOD, AND R COUNTER RELATIONSHIP

The INT, FRAC, and MOD values, in conjunction with the R counter, make it possible to generate output frequencies that are spaced by fractions of the PFD frequency. See the RF Synthesizer—A Worked Example section for more information. The RF VCO frequency (RF<sub>OUT</sub>) equation is

$$RF_{OUT} = f_{PFD} \times (INT + (FRAC/MOD)) \quad (1)$$

where RF<sub>OUT</sub> is the output frequency of external voltage controlled oscillator (VCO).

INT is the preset divide ratio of the binary 16-bit counter (23 to 65535 for 4/5 prescaler, 75 to 65,535 for 8/9 prescaler).  
MOD is the preset fractional modulus (2 to 4095).  
FRAC is the numerator of the fractional division (0 to MOD – 1).

$$f_{PFD} = REF_{IN} \times [(1 + D)/(R \times (1 + T))] \quad (2)$$

where:

REF<sub>IN</sub> is the reference input frequency.

D is the REF<sub>IN</sub> doubler bit.

T is the REF<sub>IN</sub> divide-by-2 bit (0 or 1).

R is the preset divide ratio of the binary 10-bit programmable reference counter (1 to 1023).

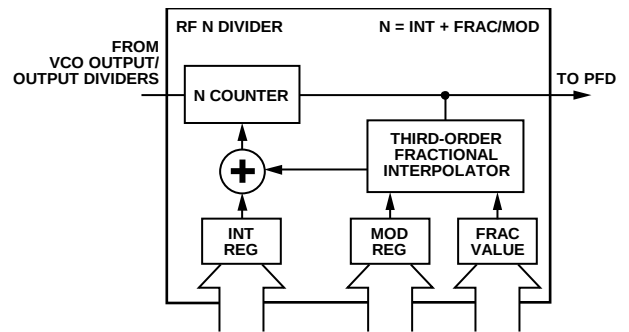


Figure 17. RF INT Divider

### INT N MODE

If the FRAC = 0 and DB8 in Register 2 (LDF) is set to 1, the synthesizer operates in integer-N mode. The DB8 in Register 2 (LDF) must be set to 1 to get integer-N digital lock detect.

### R COUNTER

The 10-bit R counter allows the input reference frequency (REF<sub>IN</sub>) to be divided down to produce the reference clock to the PFD. Division ratios from 1 to 1023 are allowed.

### PHASE FREQUENCY DETECTOR (PFD) AND CHARGE PUMP

The phase frequency detector (PFD) takes inputs from the R counter and N counter and produces an output proportional to the phase and frequency difference between them. Figure 18 is a simplified schematic of the phase frequency detector. The PFD includes a fixed delay element that sets the width of the antibacklash pulse, which is typically 3 ns. This pulse ensures there is no dead zone in the PFD transfer function, and gives a consistent reference spur level.

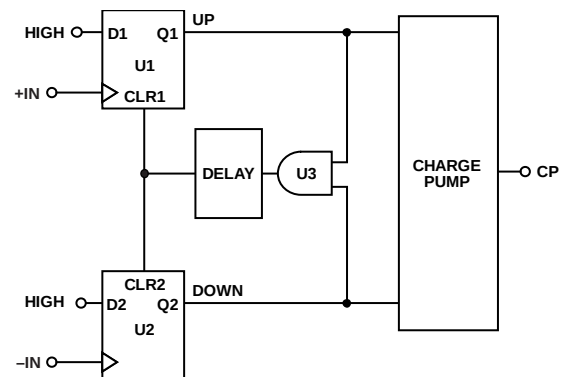


Figure 18. PFD Simplified Schematic

## MUXOUT AND LOCK DETECT

The output multiplexer on the ADF4350 allows the user to access various internal points on the chip. The state of MUXOUT is controlled by M3, M2, and M1 (for details, see Figure 26). Figure 19 shows the MUXOUT section in block diagram form.

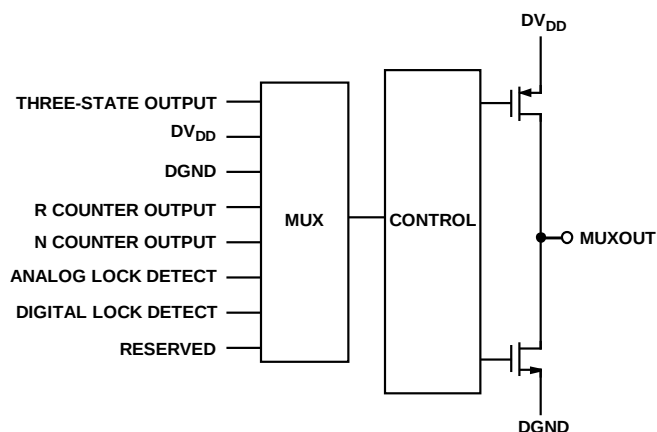


Figure 19. MUXOUT Schematic

## INPUT SHIFT REGISTERS

The ADF4350 digital section includes a 10-bit RF R counter, a 16-bit RF N counter, a 12-bit FRAC counter, and a 12-bit modulus counter. Data is clocked into the 32-bit shift register on each rising edge of CLK. The data is clocked in MSB first. Data is transferred from the shift register to one of six latches on the rising edge of LE. The destination latch is determined by the state of the three control bits (C3, C2, and C1) in the shift register. These are the 3 LSBs, DB2, DB1, and DB0, as shown in Figure 2. The truth table for these bits is shown in Table 5. Figure 23 shows a summary of how the latches are programmed.

Table 5. C3, C2, and C1 Truth Table

| Control Bits |    |    | Register        |
|--------------|----|----|-----------------|
| C3           | C2 | C1 |                 |
| 0            | 0  | 0  | Register 0 (R0) |
| 0            | 0  | 1  | Register 1 (R1) |
| 0            | 1  | 0  | Register 2 (R2) |
| 0            | 1  | 1  | Register 3 (R3) |
| 1            | 0  | 0  | Register 4 (R4) |
| 1            | 0  | 1  | Register 5 (R5) |

## PROGRAM MODES

Table 5 and Figure 23 through Figure 29 show how the program modes are to be set up in the ADF4350.

A number of settings in the ADF4350 are double buffered. These include the modulus value, phase value, R counter value, reference doubler, reference divide-by-2, and current setting. This means that two events have to occur before the device uses a new value of any of the double buffered settings. First, the new value is latched into the device by writing to the appropriate register. Second, a new write must be performed on Register R0.

For example, any time the modulus value is updated, Register 0 (R0) must be written to, to ensure the modulus value is loaded correctly. Divider select in Register 4 (R4) is also double buffered, but only if DB13 of Register 2 (R2) is high.

## VCO

The VCO core in the ADF4350 consists of three separate VCOs each of which uses 16 overlapping bands, as shown in Figure 20, to allow a wide frequency range to be covered without a large VCO sensitivity ( $K_V$ ) and resultant poor phase noise and spurious performance.

The correct VCO and band are chosen automatically by the VCO and band select logic at power-up or whenever Register 0 (R0) is updated.

VCO and band selection take 10 PFD cycles  $\times$  band select clock divider value. The VCO  $V_{TUNE}$  is disconnected from the output of the loop filter and is connected to an internal reference voltage.

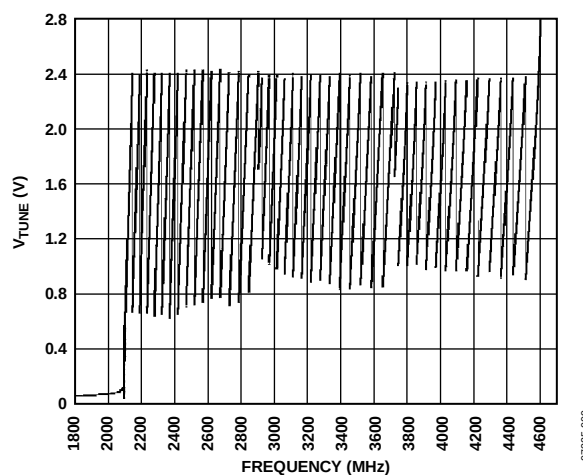


Figure 20.  $V_{TUNE}$  vs. Frequency

The use the R counter output as the clock for the band select logic. A programmable divider is provided at the R counter output to allow division by 1 to 255 and is controlled by Bits [BS8:BS1] in Register 4 (R4). When the required PFD frequency is higher than 125 kHz, the divide ratio must be set to allow enough time for correct band selection.

After band select, normal PLL action resumes. The nominal value of  $K_V$  is 33 MHz/V when the N-divider is driven from the VCO output or this value divided by D. D is the output divider value if the N-divider is driven from the RF divider output (chosen by programming Bits [D12:D10] in Register 4 (R4). The ADF4350 contains linearization circuitry to minimize any variation of the product of  $I_{CP}$  and  $K_V$  to keep the loop bandwidth constant.

The VCO shows variation of  $K_V$  as the  $V_{TUNE}$  varies within the band and from band-to-band. It has been shown for wideband applications covering a wide frequency range (and changing output dividers) that a value of 33 MHz/V provides the most accurate  $K_V$  as this is closest to an average value. Figure 21 shows how  $K_V$  varies with fundamental VCO frequency along with an average value for the frequency band. Users may prefer this figure when using narrowband designs.

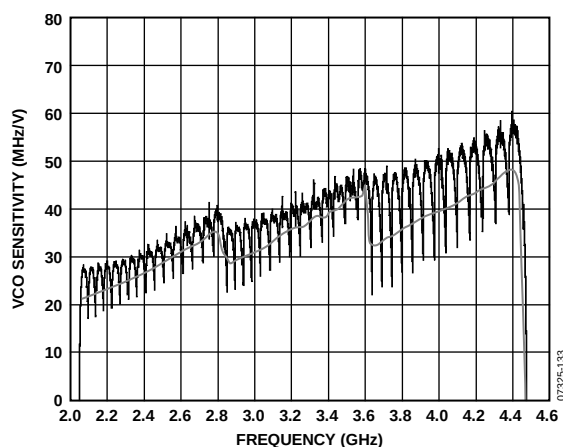


Figure 21.  $K_V$  vs. Frequency

In fixed frequency applications, the ADF4350  $V_{TUNE}$  may vary with ambient temperature switching from hot to cold. In extreme cases, the drift causes  $V_{TUNE}$  to drop to a very low level ( $<0.25$  V) and can cause loss of lock. This becomes an issue only at fundamental VCO frequencies less than 2.95 GHz and at ambient temperatures below  $0^{\circ}\text{C}$ .

In cases such as these, if the ambient temperature decreases below  $0^{\circ}\text{C}$ , the frequency needs to be reprogrammed (R0 updated) to avoid  $V_{TUNE}$  dropping to a level close to 0 V. Reprogramming the device chooses a more suitable VCO band, and thus avoids the low  $V_{TUNE}$  issue. Any further temperature drops of more than  $20^{\circ}\text{C}$  (below  $0^{\circ}\text{C}$ ) also require further reprogramming. Any increases in the ambient temperature do not require reprogramming.

## OUTPUT STAGE

The RF<sub>OUTA+</sub> and RF<sub>OUTA-</sub> pins of the ADF4350 are connected to the collectors of an NPN differential pair driven by buffered outputs of the VCO, as shown in Figure 22. To allow the user to optimize the power dissipation vs. the output power requirements, the tail current of the differential pair is programmable by Bits [D2:D1] in Register 4 (R4). Four current levels may be set. These levels give output power levels of  $-4$  dBm,  $-1$  dBm,  $+2$  dBm, and  $+5$  dBm, respectively, using a  $50\ \Omega$  resistor to  $AV_{DD}$  and ac coupling into a  $50\ \Omega$  load. Alternatively, both outputs can be combined in a  $1 + 1:1$  transformer or a  $180^{\circ}$  microstrip coupler (see the Output Matching section). If using the outputs individually, the optimum output stage consists of a shunt inductor to  $V_{VCO}$ . The unused complementary output must be terminated with a similar circuit to the used output.

An auxiliary output stage exists on Pins RF<sub>OUTB+</sub> and RF<sub>OUTB-</sub> providing a second set of differential outputs which can drive another circuit, or which can be powered down if unused. The auxiliary output must be used in conjunction with the main RF output. It cannot be used with the main output powered down.

Another feature of the ADF4350 is that the supply current to the RF output stage can be shut down until the device achieves lock as measured by the digital lock detect circuitry. This is enabled by the mute till lock detect (MTLD) bit in Register 4 (R4).

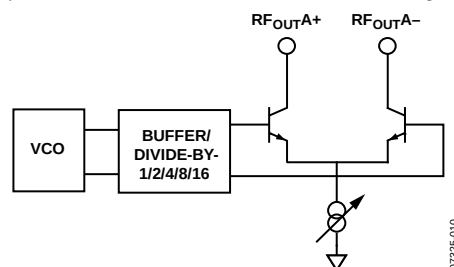


Figure 22. Output Stage

## REGISTER MAPS

REGISTER 0

| RESERVED | 16-BIT INTEGER VALUE (INT) |      |      |      |      |      |      |      |      |      |      |      |      |      |      | 12-BIT FRACTIONAL VALUE (FRAC) |      |      |      |      |      |      |     |     |     |     |     | CONTROL BITS |       |       |       |
|----------|----------------------------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|--------------------------------|------|------|------|------|------|------|-----|-----|-----|-----|-----|--------------|-------|-------|-------|
|          | DB31                       | DB30 | DB29 | DB28 | DB27 | DB26 | DB25 | DB24 | DB23 | DB22 | DB21 | DB20 | DB19 | DB18 | DB17 | DB16                           | DB15 | DB14 | DB13 | DB12 | DB11 | DB10 | DB9 | DB8 | DB7 | DB6 | DB5 | DB4          | DB3   | DB2   | DB1   |
| 0        | N16                        | N15  | N14  | N13  | N12  | N11  | N10  | N9   | N8   | N7   | N6   | N5   | N4   | N3   | N2   | N1                             | F12  | F11  | F10  | F9   | F8   | F7   | F6  | F5  | F4  | F3  | F2  | F1           | C3(0) | C2(0) | C1(0) |

REGISTER 1

| RESERVED |      |      |      | PRESCALER | 12-BIT PHASE VALUE (PHASE)      DBR <sup>1</sup> |      |      |      |      |      |      |      |      |      |      |      | 12-BIT MODULUS VALUE (MOD)      DBR <sup>1</sup> |      |      |      |      |      |     |     |     |     |     |     | CONTROL BITS |       |       |       |
|----------|------|------|------|-----------|--------------------------------------------------|------|------|------|------|------|------|------|------|------|------|------|--------------------------------------------------|------|------|------|------|------|-----|-----|-----|-----|-----|-----|--------------|-------|-------|-------|
| DB31     | DB30 | DB29 | DB28 |           | DB27                                             | DB26 | DB25 | DB24 | DB23 | DB22 | DB21 | DB20 | DB19 | DB18 | DB17 | DB16 | DB15                                             | DB14 | DB13 | DB12 | DB11 | DB10 | DB9 | DB8 | DB7 | DB6 | DB5 | DB4 |              |       |       | DB3   |
| 0        | 0    | 0    | 0    |           | PR1                                              | P12  | P11  | P10  | P9   | P8   | P7   | P6   | P5   | P4   | P3   | P2   | P1                                               | M12  | M11  | M10  | M9   | M8   | M7  | M6  | M5  | M4  | M3  | M2  | M1           | C3(0) | C2(0) | C1(1) |

REGISTER 2

| RESERVED | LOW NOISE AND LOW SPUR MODES |      | MUXOUT |      |      | REFERENCE DOUBLER DBR <sup>1</sup> | RDIV2 DBR <sup>1</sup> | 10-BIT R COUNTER DBR <sup>1</sup> |      |      |      |      |      |      |      |      |      | DOUBLE BUFF | CHARGE PUMP CURRENT SETTING DBR <sup>1</sup> |      |      |     | LDF | LDP | PD POLARITY | PD  | CP THREE-STATE | COUNTER RESET | CONTROL BITS |       |       |
|----------|------------------------------|------|--------|------|------|------------------------------------|------------------------|-----------------------------------|------|------|------|------|------|------|------|------|------|-------------|----------------------------------------------|------|------|-----|-----|-----|-------------|-----|----------------|---------------|--------------|-------|-------|
|          |                              |      |        |      |      |                                    |                        |                                   |      |      |      |      |      |      |      |      |      |             |                                              |      |      |     |     |     |             |     |                |               |              |       |       |
| DB31     | DB30                         | DB29 | DB28   | DB27 | DB26 | DB25                               | DB24                   | DB23                              | DB22 | DB21 | DB20 | DB19 | DB18 | DB17 | DB16 | DB15 | DB14 | DB13        | DB12                                         | DB11 | DB10 | DB9 | DB8 | DB7 | DB6         | DB5 | DB4            | DB3           | DB2          | DB1   | DB0   |
| 0        | L2                           | L1   | M3     | M2   | M1   | RD2                                | RD1                    | R10                               | R9   | R8   | R7   | R6   | R5   | R4   | R3   | R2   | R1   | D1          | CP4                                          | CP3  | CP2  | CP1 | U6  | U5  | U4          | U3  | U2             | U1            | C3(0)        | C2(1) | C1(0) |

REGISTER 3

| RESERVED |      |      |      |      |      |      |      |      |      |      | RESERVED |      | CSR  | RESERVED | CLK DIV MODE |      | 12-BIT CLOCK DIVIDER VALUE |      |      |      |      |     |     |     |     |     |     |     | CONTROL BITS |       |       |
|----------|------|------|------|------|------|------|------|------|------|------|----------|------|------|----------|--------------|------|----------------------------|------|------|------|------|-----|-----|-----|-----|-----|-----|-----|--------------|-------|-------|
| DB31     | DB30 | DB29 | DB28 | DB27 | DB26 | DB25 | DB24 | DB23 | DB22 | DB21 | DB20     | DB19 | DB18 | DB17     | DB16         | DB15 | DB14                       | DB13 | DB12 | DB11 | DB10 | DB9 | DB8 | DB7 | DB6 | DB5 | DB4 | DB3 | DB2          | DB1   | DB0   |
| 0        | 0    | 0    | 0    | 0    | 0    | 0    | 0    | 0    | 0    | 0    | 0        | 0    | F1   | 0        | C2           | C1   | D12                        | D11  | D10  | D9   | D8   | D7  | D6  | D5  | D4  | D3  | D2  | D1  | C3(0)        | C2(1) | C1(1) |

REGISTER 4

| RESERVED |      |      |      |      |      |      |      | FEEDBACK<br>SELECT | DBB <sup>2</sup><br>DIVIDER<br>SELECT |      |      |      | 8-BIT BAND SELECT CLOCK DIVIDER VALUE |      |      |      |      |      |      |      | VCO POWER<br>DOWN | MTLD | AUX OUTPUT<br>SELECT | AUX OUTPUT<br>ENABLE | AUX<br>OUTPUT<br>POWER | RF OUTPUT<br>ENABLE | OUTPUT<br>POWER |     | CONTROL<br>BITS |       |       |
|----------|------|------|------|------|------|------|------|--------------------|---------------------------------------|------|------|------|---------------------------------------|------|------|------|------|------|------|------|-------------------|------|----------------------|----------------------|------------------------|---------------------|-----------------|-----|-----------------|-------|-------|
| DB31     | DB30 | DB29 | DB28 | DB27 | DB26 | DB25 | DB24 | DB23               | DB22                                  | DB21 | DB20 | DB19 | DB18                                  | DB17 | DB16 | DB15 | DB14 | DB13 | DB12 | DB11 | DB10              | DB9  | DB8                  | DB7                  | DB6                    | DB5                 | DB4             | DB3 | DB2             | DB1   | DB0   |
| 0        | 0    | 0    | 0    | 0    | 0    | 0    | 0    | D13                | D12                                   | D11  | D10  | BS8  | BS7                                   | BS6  | BS5  | BS4  | BS3  | BS2  | BS1  | D9   | D8                | D7   | D6                   | D5                   | D4                     | D3                  | D2              | D1  | C3(1)           | C2(0) | C1(0) |

REGISTER 5

| RESERVED |      |      |      |      |      |      |      | LD PIN MODE |      | RESERVED | RESERVED |      | RESERVED |      |      |      |      |      |      |      |      |     |     |     |     |     |     | CONTROL BITS |       |       |       |
|----------|------|------|------|------|------|------|------|-------------|------|----------|----------|------|----------|------|------|------|------|------|------|------|------|-----|-----|-----|-----|-----|-----|--------------|-------|-------|-------|
| DB31     | DB30 | DB29 | DB28 | DB27 | DB26 | DB25 | DB24 | DB23        | DB22 | DB21     | DB20     | DB19 | DB18     | DB17 | DB16 | DB15 | DB14 | DB13 | DB12 | DB11 | DB10 | DB9 | DB8 | DB7 | DB6 | DB5 | DB4 | DB3          | DB2   | DB1   | DB0   |
| 0        | 0    | 0    | 0    | 0    | 0    | 0    | 0    | D15         | D14  | 0        | 1        | 1    | 0        | 0    | 0    | 0    | 0    | 0    | 0    | 0    | 0    | 0   | 0   | 0   | 0   | 0   | 0   | 0            | C3(1) | C2(0) | C1(1) |

<sup>1</sup> DBR = DOUBLE BUFFERED REGISTER—BUFFERED BY THE WRITE TO REGISTER 0.<sup>2</sup> DBB = DOUBLE BUFFERED BITS—BUFFERED BY THE WRITE TO REGISTER 0, IF AND ONLY IF DB13 OF REGISTER 2 IS HIGH.

Figure 23. Register Summary

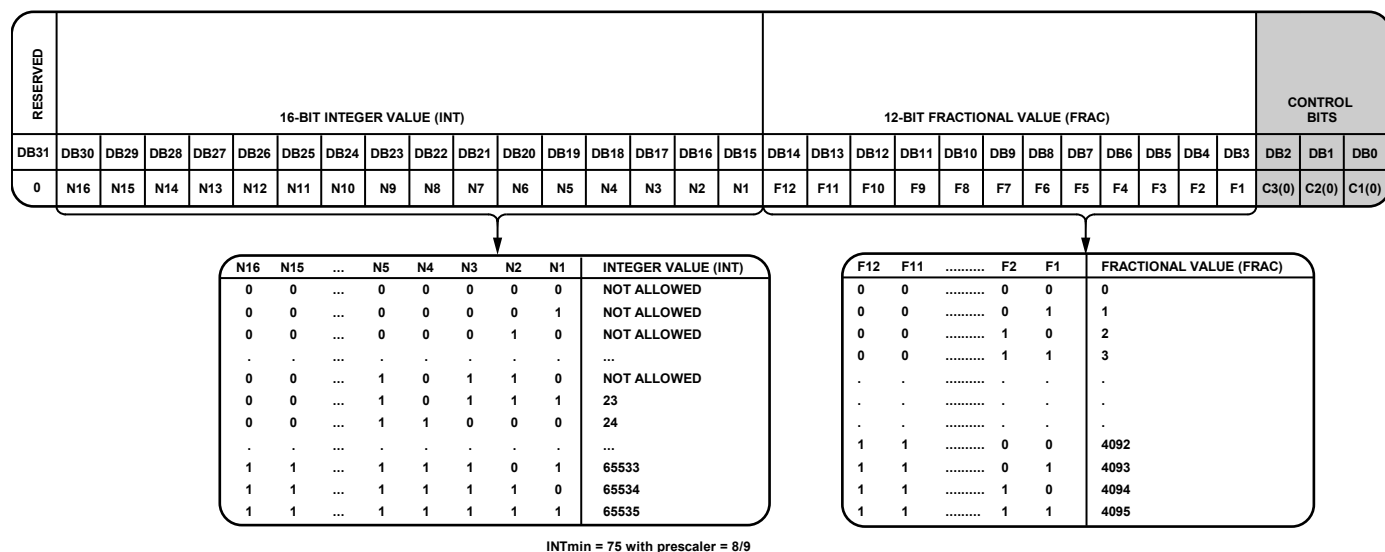


Figure 24. Register 0 (R0)

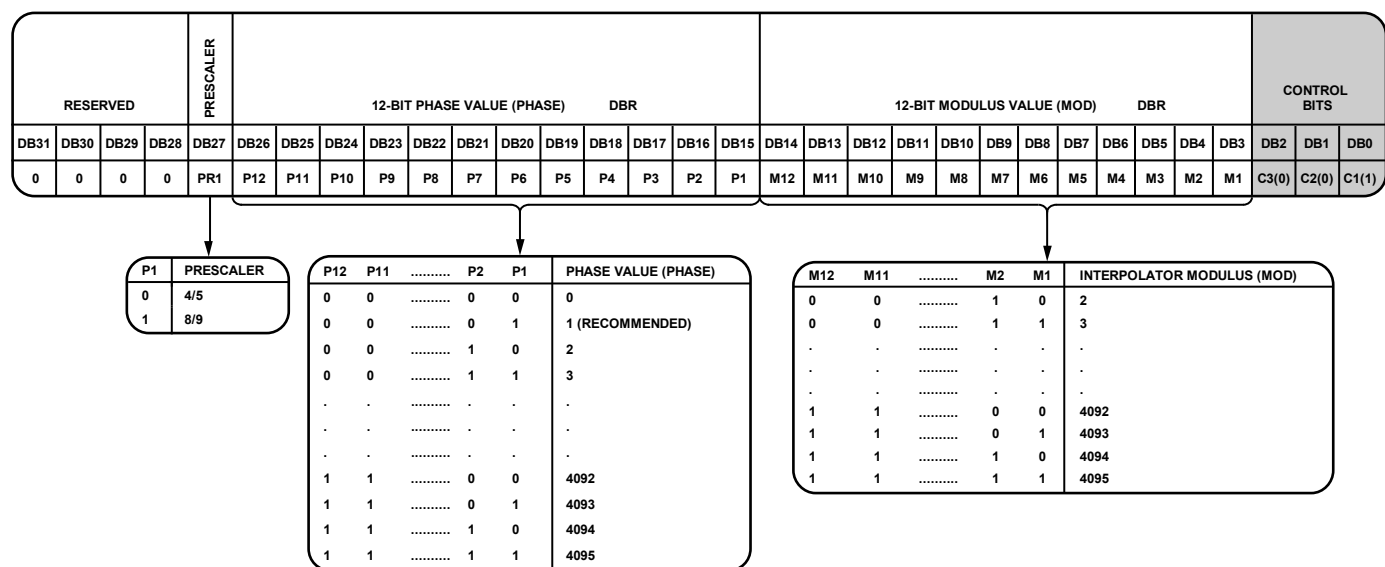


Figure 25. Register 1 (R1)

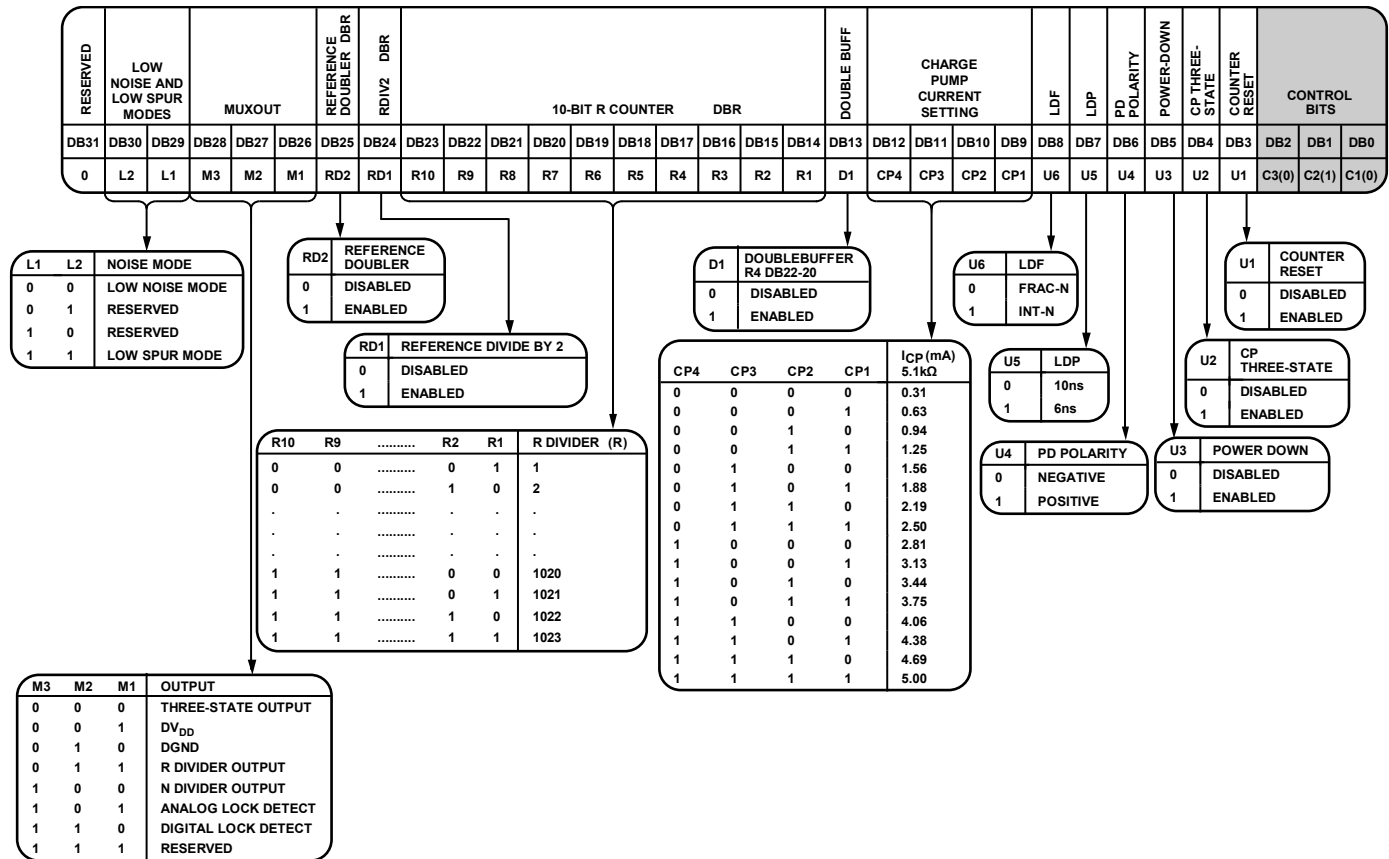


Figure 26. Register 2 (R2)

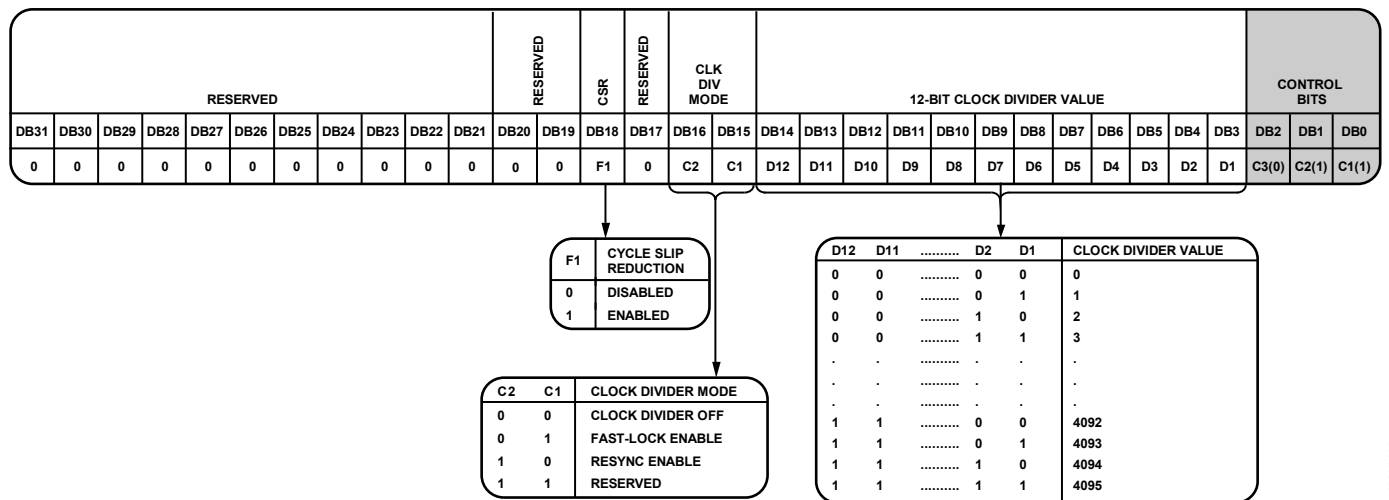
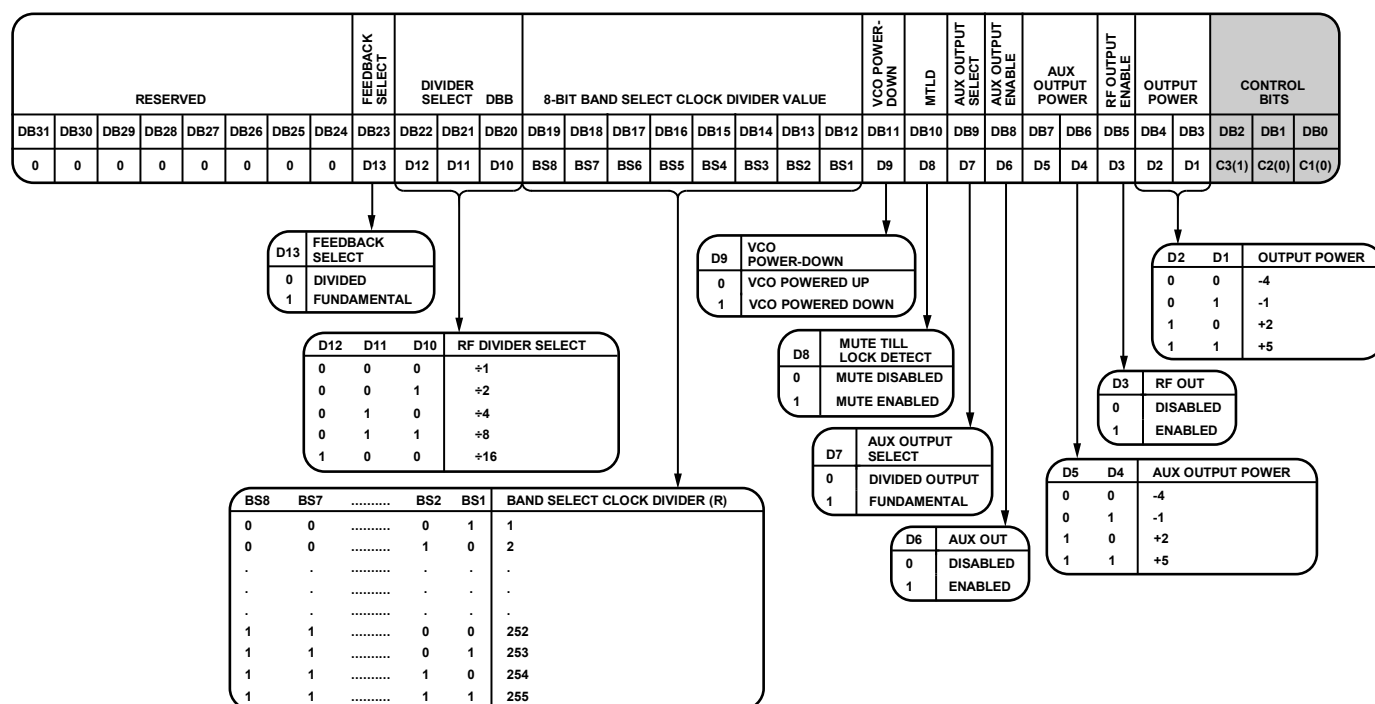


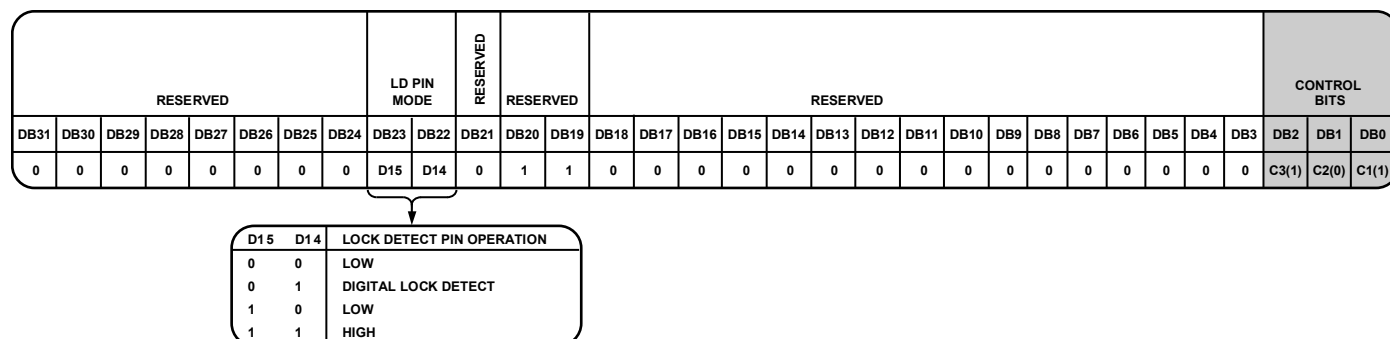
Figure 27. Register 3 (R3)





07325-016

Figure 28. Register 4 (R4)



07325-017

Figure 29. Register 5 (R5)

**REGISTER 0****Control Bits**

With Bits [C3:C1] set to 0, 0, 0, Register 0 is programmed. Figure 24 shows the input data format for programming this register.

**16-Bit INT Value**

These sixteen bits set the INT value, which determines the integer device of the feedback division factor. It is used in Equation 1 (see the INT, FRAC, MOD, and R Counter Relationship section). All integer values from 23 to 65,535 are allowed for 4/5 prescaler. For 8/9 prescaler, the minimum integer value is 75.

**12-Bit FRAC Value**

The 12 FRAC bits set the numerator of the fraction that is input to the  $\Sigma$ - $\Delta$  modulator. This, along with INT, specifies the new frequency channel that the synthesizer locks to, as shown in the RF Synthesizer—A Worked Example section. FRAC values from 0 to MOD – 1 cover channels over a frequency range equal to the PFD reference frequency.

**REGISTER 1****Control Bits**

With Bits [C3:C1] set to 0, 0, 1, Register 1 is programmed. Figure 25 shows the input data format for programming this register.

**Prescaler Value**

The dual modulus prescaler ( $P/P + 1$ ), along with the INT, FRAC, and MOD counters, determines the overall division ratio from the VCO output to the PFD input.

Operating at CML levels, the prescaler takes the clock from the VCO output and divides it down for the counters. It is based on a synchronous 4/5 core. When set to 4/5, the maximum RF frequency allowed is 3 GHz. Therefore, when operating the ADF4350 above 3 GHz, this must be set to 8/9. The prescaler limits the INT value, where P is 4/5,  $N_{MIN}$  is 23 and P is 8/9,  $N_{MIN}$  is 75.

In the ADF4350, PR1 in Register 1 sets the prescaler values.

**12-Bit Phase Value**

These bits control what is loaded as the phase word. The word must be less than the MOD value programmed in Register 1. The word programs the RF output phase from 0° to 360° with a resolution of 360°/MOD. See the Phase Resync section for more information. In most applications, the phase relationship between the RF signal and the reference is not important. In such applications, the phase value can optimize the fractional and subfractional spur levels. See the Spur Consistency and Fractional Spur Optimization section for more information.

If neither the phase resync nor the spurious optimization functions are being used, it is recommended the PHASE word be set to 1.

**12-Bit Interpolator MOD Value**

This programmable register sets the fractional modulus. This is the ratio of the PFD frequency to the channel step resolution on the RF output. See the RF Synthesizer—A Worked Example section for more information.

**REGISTER 2****Control Bits**

With Bits [C3:C1] set to 0, 1, 0, Register 2 is programmed. Figure 26 shows the input data format for programming this register.

**Low Noise and Low Spur Modes**

The noise modes on the ADF4350 are controlled by DB30 and DB29 in Register 2 (see Figure 26). The noise modes allow the user to optimize a design either for improved spurious performance or for improved phase noise performance.

When the lowest spur setting is chosen, dither is enabled. This randomizes the fractional quantization noise so it resembles white noise rather than spurious noise. As a result, the device is optimized for improved spurious performance. This operation is normally used when the PLL closed-loop bandwidth is wide, for fast-locking applications. Wide loop bandwidth is seen as a loop bandwidth greater than 1/10 of the RF<sub>OUT</sub> channel step resolution ( $f_{RES}$ ). A wide loop filter does not attenuate the spurs to the same level as a narrow loop bandwidth.

For best noise performance, use the lowest noise setting option. As well as disabling the dither, this setting also ensures that the charge pump is operating in an optimum region for noise performance. This setting is extremely useful where a narrow loop filter bandwidth is available. The synthesizer ensures extremely low noise and the filter attenuates the spurs. The typical performance characteristics give the user an idea of the trade-off in a typical W-CDMA setup for the different noise and spur settings.

**MUXOUT**

The on-chip multiplexer is controlled by Bits [DB28:DB26] (see Figure 26).

**Reference Doubler**

Setting DB25 to 0 feeds the REF<sub>IN</sub> signal directly to the 10-bit R counter, disabling the doubler. Setting this bit to 1 multiplies the REF<sub>IN</sub> frequency by a factor of 2 before feeding into the 10-bit R counter. When the doubler is disabled, the REF<sub>IN</sub> falling edge is the active edge at the PFD input to the fractional synthesizer. When the doubler is enabled, both the rising and falling edges of REF<sub>IN</sub> become active edges at the PFD input.

When the doubler is enabled and the lowest spur mode is chosen, the in-band phase noise performance is sensitive to the REF<sub>IN</sub> duty cycle. The phase noise degradation can be as much as 5 dB for the REF<sub>IN</sub> duty cycles outside a 45% to 55% range. The phase noise is insensitive to the REF<sub>IN</sub> duty cycle in the lowest noise mode and when the doubler is disabled.

The maximum allowable REF<sub>IN</sub> frequency when the doubler is enabled is 30 MHz.

#### **RDIV2**

Setting the DB24 bit to 1 inserts a divide-by-2 toggle flip-flop between the R counter and PFD, which extends the maximum REF<sub>IN</sub> input rate. This function allows a 50% duty cycle signal to appear at the PFD input, which is necessary for cycle slip reduction.

#### **10-Bit R Counter**

The 10-bit R counter allows the input reference frequency (REF<sub>IN</sub>) to be divided down to produce the reference clock to the PFD. Division ratios from 1 to 1023 are allowed.

#### **Double Buffer**

DB13 enables or disables double buffering of Bits [DB22:DB20] in Register 4. The Divider Select section explains how double buffering works.

#### **Charge Pump Current Setting**

Bits [DB12:DB09] set the charge pump current setting. This must be set to the charge pump current that the loop filter is designed with (see Figure 26).

#### **LDF**

Setting DB8 to 1 enables integer-N digital lock detect, when the FRAC part of the divider is 0; setting DB8 to 0 enables fractional-N digital lock detect.

#### **Lock Detect Precision (LDP)**

When DB7 is set to 0, 40 consecutive PFD cycles of 10 ns must occur before digital lock detect is set. When this bit is programmed to 1, 40 consecutive reference cycles of 6 ns must occur before digital lock detect is set. This refers to fractional-N digital lock detect (set DB8 to 0). With integer-N digital lock detect activated (set DB8 to 1), and DB7 set to 0, then five consecutive cycles of 6 ns need to occur before digital lock detect is set. When DB7 is set to 1, five consecutive cycles of 10 ns must occur.

#### **Phase Detector Polarity**

DB6 sets the phase detector polarity. When using a passive loop filter or noninverting active loop filter, this must be set to 1. If using an active filter with an inverting characteristic, it must be set to 0.

#### **Power-Down**

DB5 provides the programmable power-down mode. Setting this bit to 1 performs a power-down. Setting this bit to 0 returns the synthesizer to normal operation. When in software power-down mode, the device retains all information in the registers. Only if the supply voltages are removed are the register contents lost.

When a power-down is activated, the following events occur:

- The synthesizer counters are forced to their load state conditions.
- The VCO is powered down.
- The charge pump is forced into three-state mode.
- The digital lock detect circuitry is reset.
- The RF<sub>OUT</sub> buffers are disabled.
- The input register remains active and capable of loading and latching data.

#### **Charge Pump Three-State**

DB4 puts the charge pump into three-state mode when programmed to 1. It must be set to 0 for normal operation.

#### **Counter Reset**

DB3 is the R counter and N counter reset bit for the [ADF4350](#). When this is 1, the RF synthesizer N counter and R counter are held in reset. For normal operation, this bit must be set to 0.

**REGISTER 3****Control Bits**

With Bits [C3:C1] set to 0, 1, 1, Register 3 is programmed. Figure 27 shows the input data format for programming this register.

**CSR Enable**

Setting DB18 to 1 enables cycle slip reduction. This is a method for improving lock times. Note that the signal at the phase frequency detector (PFD) must have a 50% duty cycle for cycle slip reduction to work. The charge pump current setting must also be set to a minimum. See the Cycle Slip Reduction for Faster Lock Times section for more information.

**Clock Divider Mode**

Bits [DB16:DB15] must be set to 1, 0 to activate PHASE resync or 0, 1 to activate fast lock. Setting Bits [DB16:DB15] to 0, 0 disables the clock divider. See Figure 27.

**12-Bit Clock Divider Value**

The 12-bit clock divider value sets the timeout counter for activation of PHASE resync. See the Phase Resync section for more information. It also sets the timeout counter for fast lock. See the Fast-Lock Timer and Register Sequences section for more information.

**REGISTER 4****Control Bits**

With Bits [C3:C1] set to 1, 0, 0, Register 4 is programmed. Figure 28 shows the input data format for programming this register.

**Feedback Select**

DB23 selects the feedback from the VCO output to the N counter. When set to 1, the signal is taken from the VCO directly. When set to 0, it is taken from the output of the output dividers. The dividers enable covering of the wide frequency band (137.5 MHz to 4.4 GHz). When the divider is enabled and the feedback signal is taken from the output, the RF output signals of two separately configured PLLs are in phase. This is useful in some applications where the positive interference of signals is required to increase the power.

**Divider Select**

Bits [DB22:DB20] select the value of the output divider (see Figure 28).

**Band Select Clock Divider Value**

Bits [DB19:DB12] set a divider for the band select logic clock input. The output of the R counter, is by default, the value used to clock the band select logic, but, if this value is too high (>125 kHz), a divider can be switched on to divide the R counter output to a smaller value (see Figure 28).

**VCO Power-Down**

DB11 powers the VCO down or up depending on the chosen value.

**Mute Till Lock Detect**

If DB10 is set to 1, the supply current to the RF output stage is shut down until the device achieves lock as measured by the digital lock detect circuitry.

**AUX Output Select**

DB9 sets the auxiliary RF output. The selection can be either the output of the RF dividers or fundamental VCO frequency.

**AUX Output Enable**

DB8 enables or disables auxiliary RF output, depending on the chosen value.

**AUX Output Power**

Bits [DB7:DB6] set the value of the auxiliary RF output power level (see Figure 28).

**RF Output Enable**

DB5 enables or disables primary RF output, depending on the chosen value.

**Output Power**

Bits [DB4:DB3] set the value of the primary RF output power level (see Figure 28).

**REGISTER 5****Control Bits**

With Bits [C3:C1] set to 1, 0, 1, Register 5 is programmed. Figure 29 shows the input data form for programming this register.

**Lock Detect Pin Operation**

Bits [DB23:DB22] set the operation of the lock detect pin (see Figure 29).

## INITIALIZATION SEQUENCE

The following sequence of registers is the correct sequence for initial power-up of the ADF4350 after the correct application of voltages to the supply pins:

- Register 5
- Register 4
- Register 3
- Register 2
- Register 1
- Register 0

## RF SYNTHESIZER—A WORKED EXAMPLE

The following is an example how to program the ADF4350 synthesizer:

$$RF_{OUT} = [INT + (FRAC/MOD)] \times [f_{PFD}] / RF \text{ divider} \quad (3)$$

where:

$RF_{OUT}$  is the RF frequency output.

$INT$  is the integer division factor.

$FRAC$  is the fractionality.

$MOD$  is the modulus.

$RF \text{ divider}$  is the output divider that divides down the VCO frequency.

$$f_{PFD} = REF_{IN} \times [(1 + D)/(R \times (1 + T))] \quad (4)$$

where:

$REF_{IN}$  is the reference frequency input.

$D$  is the RF  $REF_{IN}$  doubler bit.

$T$  is the reference divide-by-2 bit (0 or 1).

$R$  is the RF reference division factor.

For example, in a UMTS system, where 2112.6 MHz RF frequency output ( $RF_{OUT}$ ) is required, a 10 MHz reference frequency input ( $REF_{IN}$ ) is available, and a 200 kHz channel resolution ( $f_{RESOUT}$ ) is required on the RF output. Note that the ADF4350 operates in the frequency range of 2.2 GHz to 4.4 GHz. Therefore, the RF divider of 2 must be used ( $VCO \text{ frequency} = 4225.2 \text{ MHz}$ ,  $RF_{OUT} = VCO \text{ frequency} / RF \text{ divider} = 4225.2 \text{ MHz} / 2 = 2112.6 \text{ MHz}$ ).

It is also important where the loop is closed. In this example, the loop is closed (see Figure 30).

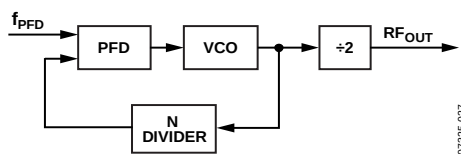


Figure 30. Loop Closed Before Output Divider

Channel resolution ( $f_{RESOUT}$ ) or 200 kHz is required at the output of the RF divider. Therefore, channel resolution at the output of the VCO ( $f_{RES}$ ) is to be twice the  $f_{RESOUT}$ , that is 400 kHz.

$$MOD = REF_{IN} / f_{RES}$$

$$MOD = 10 \text{ MHz} / 400 \text{ kHz} = 25$$

From Equation 4,

$$f_{PFD} = [10 \text{ MHz} \times (1 + 0)] / 1 = 10 \text{ MHz} \quad (5)$$

$$2112.6 \text{ MHz} = 10 \text{ MHz} \times (INT + FRAC/25) / 2 \quad (6)$$

where:

$$INT = 422$$

$$FRAC = 13$$

## MODULUS

The choice of modulus ( $MOD$ ) depends on the reference signal ( $REF_{IN}$ ) available and the channel resolution ( $f_{RES}$ ) required at the RF output. For example, a GSM system with 13 MHz  $REF_{IN}$  sets the modulus to 65. This means the RF output resolution ( $f_{RES}$ ) is the 200 kHz (13 MHz/65) necessary for GSM. With dither off, the fractional spur interval depends on the modulus values chosen (see Table 6).

## REFERENCE DOUBLER AND REFERENCE DIVIDER

The reference doubler on-chip allows the input reference signal to be doubled. This is useful for increasing the PFD comparison frequency. Making the PFD frequency higher improves the noise performance of the system. Doubling the PFD frequency usually improves noise performance by 3 dB. It is important to note that the PFD cannot operate above 32 MHz due to a limitation in the speed of the  $\Sigma$ - $\Delta$  circuit of the N-divider.

The reference divide-by-2 divides the reference signal by 2, resulting in a 50% duty cycle PFD frequency. This is necessary for the correct operation of the cycle slip reduction (CSR) function. See the Cycle Slip Reduction for Faster Lock Times section for more information.

## 12-BIT PROGRAMMABLE MODULUS

Unlike most other fractional-N PLLs, the ADF4350 allows the user to program the modulus over a 12-bit range. This means the user can set up the device in many different configurations for the application, when combined with the reference doubler and the 10-bit R counter.

For example, consider an application that requires 1.75 GHz RF and 200 kHz channel step resolution. The system has a 13 MHz reference signal.

One possible setup is feeding the 13 MHz directly to the PFD and programming the modulus to divide by 65. This results in the required 200 kHz resolution.

Another possible setup is using the reference doubler to create 26 MHz from the 13 MHz input signal. This 26 MHz is then fed into the PFD programming the modulus to divide by 130. This also results in 200 kHz resolution and offers superior phase noise performance over the previous setup.

The programmable modulus is also very useful for multi-standard applications. If a dual-mode phone requires PDC and GSM 1800 standards, the programmable modulus is a great benefit. PDC requires 25 kHz channel step resolution, whereas GSM 1800 requires 200 kHz channel step resolution.

A 13 MHz reference signal can be fed directly to the PFD, and the modulus can be programmed to 520 when in PDC mode ( $13 \text{ MHz}/520 = 25 \text{ kHz}$ ).

The modulus needs to be reprogrammed to 65 for GSM 1800 operation ( $13 \text{ MHz}/65 = 200 \text{ kHz}$ ).

It is important that the PFD frequency remain constant (13 MHz). This allows the user to design one loop filter for both setups without running into stability issues. It is important to remember that the ratio of the RF frequency to the PFD frequency principally affects the loop filter design, not the actual channel spacing.

### CYCLE SLIP REDUCTION FOR FASTER LOCK TIMES

As outlined in the Low Noise and Low Spur Mode section, the ADF4350 contains a number of features that allow optimization for noise performance. However, in fast locking applications, the loop bandwidth generally needs to be wide, and therefore, the filter does not provide much attenuation of the spurs. If the cycle slip reduction feature is enabled, the narrow loop bandwidth is maintained for spur attenuation but faster lock times are still possible.

#### Cycle Slips

Cycle slips occur in integer-N/fractional-N synthesizers when the loop bandwidth is narrow compared to the PFD frequency. The phase error at the PFD inputs accumulates too fast for the PLL to correct, and the charge pump temporarily pumps in the wrong direction. This slows down the lock time dramatically. The ADF4350 contains a cycle slip reduction feature that extends the linear range of the PFD, allowing faster lock times without modifications to the loop filter circuitry.

When the circuitry detects that a cycle slip is about to occur, it turns on an extra charge pump current cell. This outputs a constant current to the loop filter, or removes a constant current from the loop filter (depending on whether the VCO tuning voltage needs to increase or decrease to acquire the new frequency). The effect is that the linear range of the PFD is increased. Loop stability is maintained because the current is constant and is not a pulsed current.

If the phase error increases again to a point where another cycle slip is likely, the ADF4350 turns on another charge pump cell. This continues until the ADF4350 detects the VCO frequency has gone past the desired frequency. The extra charge pump cells are turned off one by one until all the extra charge pump cells have been disabled and the frequency is settled with the original loop filter bandwidth.

Up to seven extra charge pump cells can be turned on. In most applications, it is enough to eliminate cycle slips altogether, giving much faster lock times.

Setting Bit DB18 in the Register 3 to 1 enables cycle slip reduction. Note that the PFD requires a 45% to 55% duty cycle for CSR to operate correctly. If the  $\text{REF}_{\text{IN}}$  frequency does not have a suitable duty cycle, the RDIV2 mode ensures that the input to the PFD has a 50% duty cycle.

### SPURIOUS OPTIMIZATION AND FAST LOCK

Narrow loop bandwidths can filter unwanted spurious signals, but these usually have a long lock time. A wider loop bandwidth will achieve faster lock times, but a wider loop bandwidth may lead to increased spurious signals inside the loop bandwidth.

The fast lock feature can achieve the same fast lock time as the wider bandwidth, but with the advantage of a narrow final loop bandwidth to keep spurs low.

### FAST-LOCK TIMER AND REGISTER SEQUENCES

If using the fast-lock mode, a timer value must be loaded into the PLL to determine the duration of the wide bandwidth mode.

When Bits [DB16:DB15] in Register 3 are set to 0, 1 (fast-lock enable), the timer value is loaded by the 12-bit clock divider value. The following sequence must be programmed to use fast lock:

1. Initialization sequence (see the Initialization Sequence section) occurs only once after powering up the device.
2. Load Register 3 by setting Bits [DB16:DB15] to 0, 1 and the chosen fast-lock timer value [DB14:DB3]. Note that the duration the PLL remains in wide bandwidth is equal to the fast-lock timer/ $f_{\text{PFD}}$ .

### FAST LOCK—AN EXAMPLE

If a PLL has reference frequencies of 13 MHz and  $f_{\text{PFD}} = 13 \text{ MHz}$  and a required lock time of 50  $\mu\text{s}$ , the PLL is set to wide bandwidth for 40  $\mu\text{s}$ . This example assumes a modulus of 65 for channel spacing of 200 kHz. This example does not account for the time required for VCO band select.

If the time period set for the wide bandwidth is 40  $\mu\text{s}$ , then

$$\text{Fast-Lock Timer Value} = \text{Time in Wide Bandwidth} \times f_{\text{PFD}}/\text{MOD}$$

$$\text{Fast-Lock Timer Value} = 40 \mu\text{s} \times 13 \text{ MHz}/65 = 8$$

Therefore, a value of 8 must be loaded into the clock divider value in Register 3 in Step 1 of the sequence described in the Fast-Lock Timer and Register Sequences section.

## FAST LOCK—LOOP FILTER TOPOLOGY

To use fast-lock mode, the damping resistor in the loop filter is reduced to  $\frac{1}{4}$  of the value while in wide bandwidth mode. To achieve the wider loop filter bandwidth, the charge pump current increases by a factor of 16 and to maintain loop stability the damping resistor must be reduced a factor of  $\frac{1}{4}$ . To enable fast lock, the SW pin is shorted to the GND pin by settings Bits [DB16:DB15] in Register 3 to 0, 1. The following two topologies are available:

- The damping resistor (R1) is divided into two values (R1 and R1A) that have a ratio of 1:3 (see Figure 31).
- An extra resistor (R1A) is connected directly from SW, as shown in Figure 32. The extra resistor is calculated such that the parallel combination of an extra resistor and the damping resistor (R1) is reduced to  $\frac{1}{4}$  of the original value of R1 (see Figure 32).

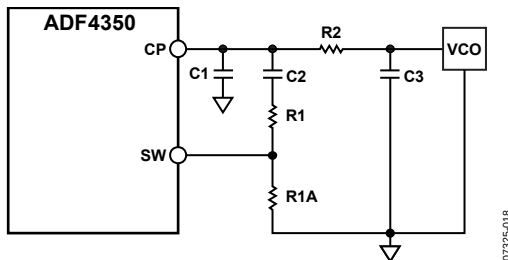


Figure 31. Fast-Lock Loop Filter Topology—Topology 1

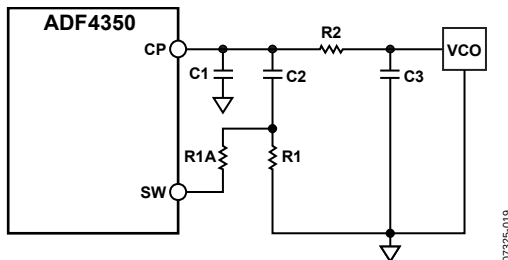


Figure 32. Fast-Lock Loop Filter Topology—Topology 2

## SPUR MECHANISMS

This section describes the three different spur mechanisms that arise with a fractional-N synthesizer and how to minimize them in the ADF4350.

### Fractional Spurs

The fractional interpolator in the ADF4350 is a third-order  $\Sigma$ - $\Delta$  modulator (SDM) with a modulus (MOD) that is programmable to any integer value from 2 to 4095. In low spur mode (dither enabled) the minimum allowable value of MOD is 50. The SDM is clocked at the PFD reference rate ( $f_{\text{PFD}}$ ) that allows PLL output frequencies to be synthesized at a channel step resolution of  $f_{\text{PFD}}/\text{MOD}$ .

In low noise mode (dither disabled) the quantization noise from the  $\Sigma$ - $\Delta$  modulator appears as fractional spurs. The interval between spurs is  $f_{\text{PFD}}/L$ , where L is the repeat length of the code sequence in the digital  $\Sigma$ - $\Delta$  modulator. For the third-order modulator used in the ADF4350, the repeat length depends on the value of MOD, as listed in Table 6.

Table 6. Fractional Spurs with Dither Disabled

| Condition (Dither Disabled)         | Repeat Length         | Spur Interval  |
|-------------------------------------|-----------------------|----------------|
| If MOD is divisible by 2, but not 3 | $2 \times \text{MOD}$ | Channel step/2 |
| If MOD is divisible by 3, but not 2 | $3 \times \text{MOD}$ | Channel step/3 |
| If MOD is divisible by 6            | $6 \times \text{MOD}$ | Channel step/6 |
| Otherwise                           | MOD                   | Channel step   |

In low spur mode (dither enabled), the repeat length is extended to  $2^{21}$  cycles, regardless of the value of MOD, which makes the quantization error spectrum look like broadband noise. This may degrade the in-band phase noise at the PLL output by as much as 10 dB. For lowest noise, dither disabled is a better choice, particularly when the final loop bandwidth is low enough to attenuate even the lowest frequency fractional spur.

### Integer Boundary Spurs

Another mechanism for fractional spur creation is the interactions between the RF VCO frequency and the reference frequency. When these frequencies are not integer related (the point of a fractional-N synthesizer) spur sidebands appear on the VCO output spectrum at an offset frequency that corresponds to the beat note or difference frequency between an integer multiple of the reference and the VCO frequency. These spurs are attenuated by the loop filter and are more noticeable on channels close to integer multiples of the reference where the difference frequency can be inside the loop bandwidth, therefore, the name integer boundary spurs.

### Reference Spurs

Reference spurs are generally not a problem in fractional-N synthesizers because the reference offset is far outside the loop bandwidth. However, any reference feed-through mechanism that bypasses the loop may cause a problem. Feed through of low levels of on-chip reference switching noise, through the  $\text{RF}_{\text{IN}}$  pin back to the VCO, can result in reference spur levels as high as  $-90$  dBc. PCB layout needs to ensure adequate isolation between VCO traces and the input reference to avoid a possible feed through path on the board.



## SPUR CONSISTENCY AND FRACTIONAL SPUR OPTIMIZATION

With dither off, the fractional spur pattern due to the quantization noise of the SDM also depends on the particular phase word with which the modulator is seeded.

The phase word can be varied to optimize the fractional and subfractional spur levels on any particular frequency. Thus, a look-up table of phase values corresponding to each frequency can be constructed for use when programming the ADF4350.

If a look-up table is not used, keep the phase word at a constant value to ensure consistent spur levels on any particular frequency.

## PHASE RESYNC

The output of a fractional-N PLL can settle to any one of the MOD phase offsets with respect to the input reference, where MOD is the fractional modulus. The phase resync feature in the ADF4350 produces a consistent output phase offset with respect to the input reference. This is necessary in applications where the output phase and frequency are important, such as digital beam forming. See the Phase Programmability section to program a specific RF output phase when using phase resync.

Phase resync is enabled by setting Bits [DB16:DB15] in Register 3 to 1, 0. When phase resync is enabled, an internal timer generates sync signals at intervals of  $t_{\text{SYNC}}$  given by the following formula:

$$t_{\text{SYNC}} = \text{CLK\_DIV\_VALUE} \times \text{MOD} \times t_{\text{PFD}}$$

where:

$t_{\text{PFD}}$  is the PFD reference period.

$\text{CLK\_DIV\_VALUE}$  is the decimal value programmed in Bits [DB14:DB3] of Register 3 and can be any integer in the range of 1 to 4095.

$\text{MOD}$  is the modulus value programmed in Bits [DB14:DB3] of Register 1 (R1).

When a new frequency is programmed, the second sync pulse after the LE rising edge resynchronizes the output phase to the reference. The  $t_{\text{SYNC}}$  time is to be programmed to a value that is as least as long as the worst-case lock time. This guarantees the phase resync occurs after the last cycle slip in the PLL settling transient.

In the example shown in Figure 33, the PFD reference is 25 MHz and MOD = 125 for a 200 kHz channel spacing.  $t_{\text{SYNC}}$  is set to 400  $\mu\text{s}$  by programming CLK\_DIV\_VALUE = 80.

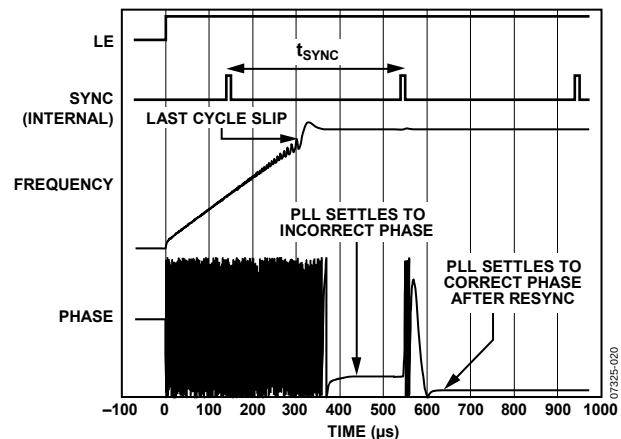


Figure 33. Phase Resync Example

## Phase Programmability

The phase word in Register 1 controls the RF output phase. As this word is swept from 0 to MOD, the RF output phase sweeps over a 360° range in steps of 360°/MOD.



## DIRECT CONVERSION MODULATOR

The LO ports of the [ADL5375](#) can be driven differentially from the complementary RF<sub>OUTA</sub> and RF<sub>OUTB</sub> outputs of the [ADF4350](#).

The RF output is designed to drive a 50  $\Omega$  load, but must be ac-coupled, as shown in Figure 34. If the I and Q inputs are driven in quadrature by 2 V p-p signals, the resulting output power from the modulator is approximately 2 dBm.



## INTERFACING

The ADF4350 has a simple SPI-compatible serial interface for writing to the device. CLK, DATA, and LE control the data transfer. When LE goes high, the 32 bits that have been clocked into the appropriate register on each rising edge of CLK are transferred to the appropriate latch. See Figure 2 for the timing diagram and Table 5 for the register address table.

### ADuC7019 to ADuC7022 and ADuC7024 to ADuC7029 Family Interface

Figure 35 shows the interface between the ADF4350 and the ADuC7019/ADuC7020/ADuC7021/ADuC7022/ADuC7024/ADuC7025/ADuC7026/ADuC7027/ADuC7028/ADuC7029 family of analog microcontrollers. The ADuC7019 to ADuC7022 and ADuC7024 to ADuC7029 family is based on an AMR7 core, although the same interface can be used with any 8051-based microcontroller. The microcontroller is set up for SPI master mode with CPHA = 0. To initiate the operation, the input/output port driving LE is brought low. Each latch of the ADF4350 needs a 32-bit word. This is accomplished by writing four 8-bit bytes from the microcontroller to the device. When the last byte is written, the LE input must be brought high to complete the transfer.

On first applying power to the ADF4350, it needs six writes (one each to R5, R4, R3, R2, R1, R0) for the output to become active.

Input/output port lines on the microcontroller are also used to control power-down (CE input) and to detect lock (MUXOUT configured as lock detect and polled by the port input).

When operating in the mode described, the maximum SPI transfer rate of the ADuC7023 is 20 Mbps. This means that the maximum rate at which the output frequency can be changed is 833 kHz. If using a faster SPI clock just make sure the SPI timing requirements listed in Table 2 are adhered to.

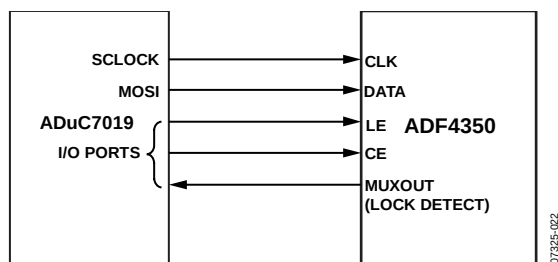


Figure 35. ADuC7019 to ADF4350 Interface

### ADSP-BF527 Interface

Figure 36 shows the interface between the ADF4350 and the Blackfin® ADSP-BF527 digital signal processor (DSP). The ADF4350 needs a 32-bit serial word for each latch write. The easiest way to accomplish this using the Blackfin family is to use the autobuffered transmit mode of operation with alternate framing. This provides a means for transmitting an entire block of serial data before an interrupt is generated. Set up the word length for 8 bits and use three memory locations for each 32-bit word. To program each 32-bit latch, store the four 8-bit bytes, enable the autobuffered mode, and write to the transmit register of the DSP. This last operation initiates the autobuffer transfer. Make sure the clock speeds are within the maximum limits outlined in Table 2.

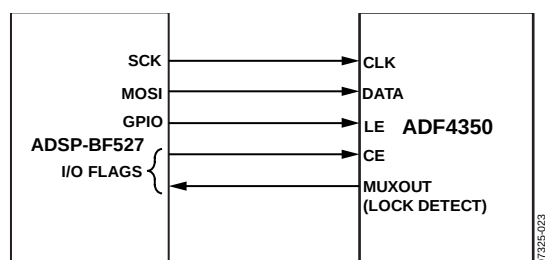


Figure 36. ADSP-BF527 to ADF4350 Interface

## PCB DESIGN GUIDELINES FOR A CHIP SCALE PACKAGE

The lands on the chip scale package (CP-32-2) are rectangular. The PCB pad for these is to be 0.1 mm longer than the package land length and 0.05 mm wider than the package land width. The land is to be centered on the pad. This ensures the solder joint size is maximized. The bottom of the chip scale package has a central thermal pad.

The thermal pad on the PCB is to be at least as large as the exposed pad. On the PCB, there is to be a minimum clearance of 0.25 mm between the thermal pad and the inner edges of the pad pattern. This ensures that shorting is avoided.

Thermal vias can be used on the PCB thermal pad to improve the thermal performance of the package. If vias are used, they are to be incorporated in the thermal pad at 1.2 mm pitch grid. The via diameter is to be between 0.3 mm and 0.33 mm, and the via barrel is to be plated with 1 oz. of copper to plug the via.

## OUTPUT MATCHING

There are a number of ways to match the output of the [ADF4350](#) for optimum operation; the most basic is to use a 50  $\Omega$  resistor to  $V_{VCO}$ . A dc bypass capacitor of 100 pF is connected in series as shown in Figure 37. Because the resistor is not frequency dependent, this provides a good broadband match. Placing the output power in this circuit into a 50  $\Omega$  load typically gives values chosen by Bit D2 and Bit D1 in Register 4 (R4).

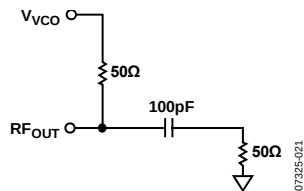


Figure 37. Simple [ADF4350](#) Output Stage

A better solution is to use a shunt inductor (acting as an RF choke) to  $V_{VCO}$ . This gives a better match and, therefore, more output power.

Experiments have shown the circuit shown in Figure 38 provides an excellent match to 50  $\Omega$  for the W-CDMA UMTS Band 1 (2110 MHz to 2170 MHz). The maximum output power in that case is about 5 dBm. Both single-ended architectures can be examined using the [EVAL-ADF4350EB1Z](#) evaluation board.

Table 7 provides a suggested range of values for the capacitor and choke inductor for different frequency ranges.

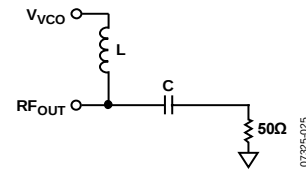


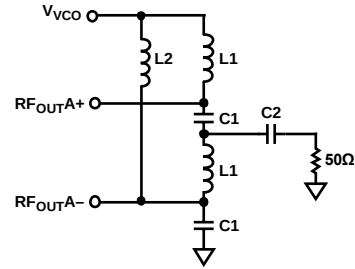
Figure 38. Optimum [ADF4350](#) Output Stage

S11 parameters are provided in Table 9.

**Table 7. Matching Components**

| Frequency Range (MHz) | L (nH) | C (nF) |
|-----------------------|--------|--------|
| 137.5 to 500          | 100    | 1      |
| 500 to 1000           | 47     | 1      |
| 1000 to 2000          | 7.5    | 1      |
| 2000 to 4400          | 3.9    | 1      |

If differential outputs are not required, the unused output can be terminated or both outputs can be combined using a balun. Unused terminated outputs must have the same shunt and series components and a load resistor to GND. If the auxiliary output is unused (disabled in software), then the RF<sub>OUT</sub>B± pins can be left open circuit.



**Figure 39. ADF4350 LC Balun**

A balun using discrete inductors and capacitors may be implemented with the architecture in Figure 39.

Component L1 and Component C1 comprise the LC balun, L2 provides a dc path for RF<sub>OUT</sub>A–, and Capacitor C2 is used for dc blocking. better solution is to use a shunt inductor (acting as an RF choke) to V<sub>VCO</sub>. This gives a better match and, therefore, more output power.

Experiments have shown the circuit shown in Figure 38 provides an excellent match to 50 Ω for the W-CDMA UMTS Band 1 (2110 MHz to 2170 MHz). The maximum output power in that case is about 5 dBm. Both single-ended architectures can be examined using the [EVAL-ADF4350EB1Z](#) evaluation board.

**Table 8. LC Balun Components**

| Frequency Range (MHz) | Inductor L1 (nH) | Capacitor C1 (pF) | RF Choke Inductor (nH) | DC Blocking Capacitor (pF) | Measured Output Power (dBm) |
|-----------------------|------------------|-------------------|------------------------|----------------------------|-----------------------------|
| 137 to 300            | 100              | 10                | 390                    | 1000                       | 9                           |
| 300 to 460            | 51               | 5.6               | 180                    | 120                        | 10                          |
| 400 to 600            | 30               | 5.6               | 120                    | 120                        | 10                          |
| 600 to 900            | 18               | 4                 | 68                     | 120                        | 10                          |
| 860 to 1240           | 12               | 2.2               | 39                     | 10                         | 9                           |
| 1200 to 1600          | 5.6              | 1.2               | 15                     | 10                         | 9                           |
| 1600 to 3600          | 3.3              | 0.7               | 10                     | 10                         | 8                           |
| 2800 to 3800          | 2.2              | 0.5               | 10                     | 10                         | 8                           |

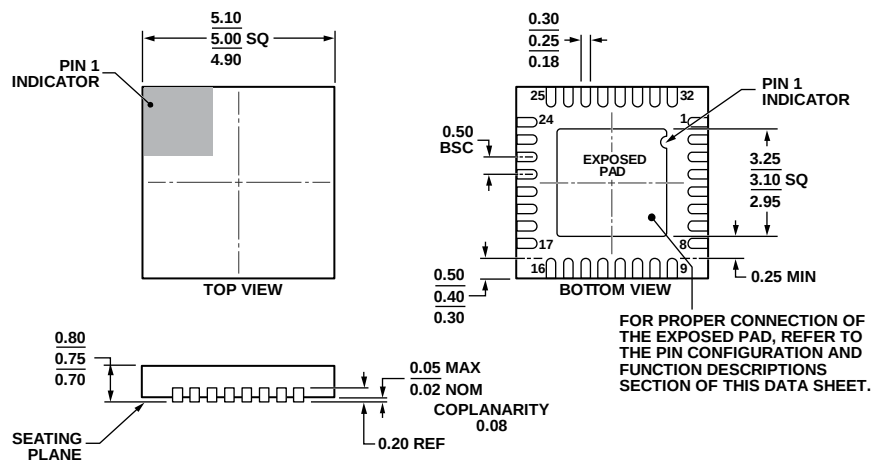
Table 9. RF<sub>OUTA</sub>+ S-Parameters (S11)

| # GHz S MA R 50 |      |        |
|-----------------|------|--------|
| FREQ            | MAG  | ANG    |
| 0.10            | 0.96 | −3.65  |
| 0.15            | 0.94 | −4.41  |
| 0.20            | 0.93 | −4.52  |
| 0.25            | 0.92 | −4.41  |
| 0.30            | 0.92 | −4.82  |
| 0.35            | 0.92 | −5.25  |
| 0.40            | 0.91 | −5.74  |
| 0.45            | 0.91 | −6.3   |
| 0.50            | 0.91 | −7.32  |
| 0.55            | 0.9  | −8.22  |
| 0.60            | 0.9  | −9.4   |
| 0.65            | 0.89 | −10.61 |
| 0.70            | 0.89 | −10.96 |
| 0.75            | 0.89 | −11.68 |
| 0.80            | 0.89 | −12.3  |
| 0.85            | 0.89 | −12.84 |
| 0.90            | 0.88 | −13.55 |
| 0.95            | 0.88 | −14.13 |
| 1.00            | 0.87 | −14.84 |
| 1.05            | 0.86 | −15.76 |
| 1.10            | 0.86 | −16.63 |
| 1.15            | 0.86 | −17.51 |
| 1.20            | 0.85 | −18.43 |
| 1.25            | 0.85 | −19.38 |
| 1.30            | 0.85 | −20.4  |
| 1.35            | 0.84 | −21.61 |
| 1.40            | 0.83 | −22.63 |
| 1.45            | 0.82 | −22.92 |
| 1.50            | 0.81 | −23.82 |
| 1.55            | 0.81 | −24.82 |
| 1.60            | 0.8  | −25.58 |
| 1.65            | 0.8  | −26.71 |
| 1.70            | 0.79 | −28.05 |
| 1.75            | 0.78 | −29.63 |
| 1.80            | 0.75 | −30.12 |
| 1.85            | 0.74 | −29.82 |
| 1.90            | 0.74 | −30.3  |
| 1.95            | 0.74 | −31.36 |
| 2.00            | 0.74 | −32.63 |
| 2.05            | 0.73 | −33.78 |
| 2.10            | 0.72 | −35.08 |
| 2.15            | 0.71 | −36.83 |
| 2.20            | 0.69 | −37.98 |
| 2.25            | 0.67 | −38.42 |
| 2.30            | 0.65 | −38.78 |
| 2.35            | 0.64 | −39.43 |
| 2.40            | 0.63 | −40.44 |
| 2.45            | 0.62 | −41.55 |
| 2.50            | 0.61 | −42.55 |
| 2.55            | 0.6  | −43.8  |
| 2.60            | 0.59 | −44.97 |

## # GHz S M A R 50

| FREQ | MAG  | ANG    |
|------|------|--------|
| 2.65 | 0.58 | −45.93 |
| 2.70 | 0.57 | −46.5  |
| 2.75 | 0.57 | −47.11 |
| 2.80 | 0.55 | −47.7  |
| 2.85 | 0.54 | −48.54 |
| 2.90 | 0.52 | −49.63 |
| 2.95 | 0.51 | −50.71 |
| 3.00 | 0.49 | −51.89 |
| 3.05 | 0.48 | −53.42 |
| 3.10 | 0.47 | −54.56 |
| 3.15 | 0.46 | −55.71 |
| 3.20 | 0.45 | −56.38 |
| 3.25 | 0.44 | −56.99 |
| 3.30 | 0.43 | −57.9  |
| 3.35 | 0.42 | −58.92 |
| 3.40 | 0.41 | −60.17 |
| 3.45 | 0.4  | −61.49 |
| 3.50 | 0.38 | −63.02 |
| 3.55 | 0.37 | −64.37 |
| 3.60 | 0.36 | −65.52 |
| 3.65 | 0.35 | −66.53 |
| 3.70 | 0.34 | −67.53 |
| 3.75 | 0.33 | −69.16 |
| 3.80 | 0.32 | −70.75 |
| 3.85 | 0.31 | −72.04 |
| 3.90 | 0.3  | −73.73 |
| 3.95 | 0.28 | −75.85 |
| 4.00 | 0.27 | −78.25 |
| 4.05 | 0.26 | −81.03 |
| 4.10 | 0.26 | −83.45 |
| 4.15 | 0.25 | −85.67 |
| 4.20 | 0.25 | −87.63 |
| 4.25 | 0.24 | −89.61 |
| 4.30 | 0.23 | −91.6  |
| 4.35 | 0.22 | −93.91 |
| 4.40 | 0.21 | −97.18 |

## OUTLINE DIMENSIONS



112408-A

## ORDERING GUIDE

| Model <sup>1</sup> | Temperature Range | Package Description                                          | Package Option |
|--------------------|-------------------|--------------------------------------------------------------|----------------|
| ADF4350BCPZ        | −40°C to +85°C    | 32-Lead Lead Frame Chip Scale Package [LFCSP]                | CP-32-7        |
| ADF4350BCPZ-RL     | −40°C to +85°C    | 32-Lead Lead Frame Chip Scale Package [LFCSP]                | CP-32-7        |
| ADF4350BCPZ-RL7    | −40°C to +85°C    | 32-Lead Lead Frame Chip Scale Package [LFCSP]                | CP-32-7        |
| EVAL-ADF4350EB1Z   |                   | Evaluation Board, Primary RF Output Available                |                |
| EVAL-ADF4350EB2Z   |                   | Evaluation Board, Primary and Auxiliary RF Outputs Available |                |

<sup>1</sup> Z = RoHS Compliant Part.

**NOTES**



## NOTES

**NOTES**